

MAINTENANCE MANUAL  
ORION™  
136-174 MHz (Dual Bandwidth)  
CONTROL LOGIC/IF BOARD  
CMC-682D/CMF-135D

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DESCRIPTION

The System Control Logic/IF board consists of the following control, IF and audio circuits (see figures 1 & 2).

SYSTEM CONTROL LOGIC (CMC-682D)

- CMOS Microprocessor (IC701, IC702)
- Custom CMOS ASIC Chip (IC703)
- Address Decoder (IC704)
- RS-485 (IC705)
- RS-232 (IC706)
- Flash EEPROM (IC707)
- EEPROM (IC708)
- CMOS SRAM (IC709)
- CMOS Inverters (IC711)
- Silicon Serial Number (IC712)
- TTL Inverters (IC713)
- Dual Flip-Flop (IC714)

IF (CMF-135D)

- Custom CMOS ASP Chip (IC601)
- Operational Amplifier (IC602, IC603)
- Audio Amplifier (IC604)
- 5 Volt Regulator (IC606, IC607)
- 9 Volt Regulator (IC605, IC608, IC609)
- Comparator Circuit (IC610)
- Bilateral Switch (IC611, IC612, IC613)
- Operational Amplifier (IC614)

CIRCUIT ANALYSIS

LOGIC SECTION (CMC-682D)

Microcomputer

The main microcomputer circuit in the **ORION** radio consist of microprocessor IC701, EEPROM IC708, Flash EEPROM IC707, RAM IC709 and custom ASIC IC703. This circuitry runs at a 9.8304 MHz rate determined by crystal X701 and controls the radio through a second microprocessor IC702. This second microprocessor runs at a 4.9152 MHz rate. The 4.9152 MHz rate is determined by ASIC IC703. The microcomputer circuit performs the following functions for the radio:

- Controlling the **ASIC, FLASH EEPROM** and **RAM**
- Loading data to the frequency synthesizer
- Fetching and processing the PTT, monitor, channel, selection and volume control
- Controlling the audio circuit (processor)
- Decoding the squelch
- Encoding/Decoding the Channel Guard and Digital Channel Guard
- Controlling the loading interface for the radio data (channel number and signaling)

FLASH EEPROM (IC707)

This memory contains the software to control the microprocessor. This Flash EEPROM has a storage capacity of 512k x 8 bits.

CMOS SRAM (IC709)

This SCRATCH RAM has a storage capacity of 32k x 8 bits. The memory is available for variables, buffers, etc.

EEPROM (IC708)

This EEPROM has a storage capacity of 8k x 8 bits. The memory contains the user configurable parameters that must be maintained through a power cycle. This personality controls various functions of the radio. The personality data is entered from outside the radio through the ORCC connector to the microprocessor and then to the EEPROM.

- The data mainly consists of the following:
- Chanel Frequency Data
  - CG/DCG Data
  - Tx Power, Tx MODulation Data
  - Squelch Data
  - Display Data, etc.

APPLICATION OF SPECIFIC INTEGRATED CIRCUITS

ASIC (IC703)

The ASIC is basically a chip that integrates many miscellaneous functions. The chip provides functions as follows:

- MODEM
- Watch Dog Timer
- Clock Control
- Interrupt Control
- Address Decode etc.

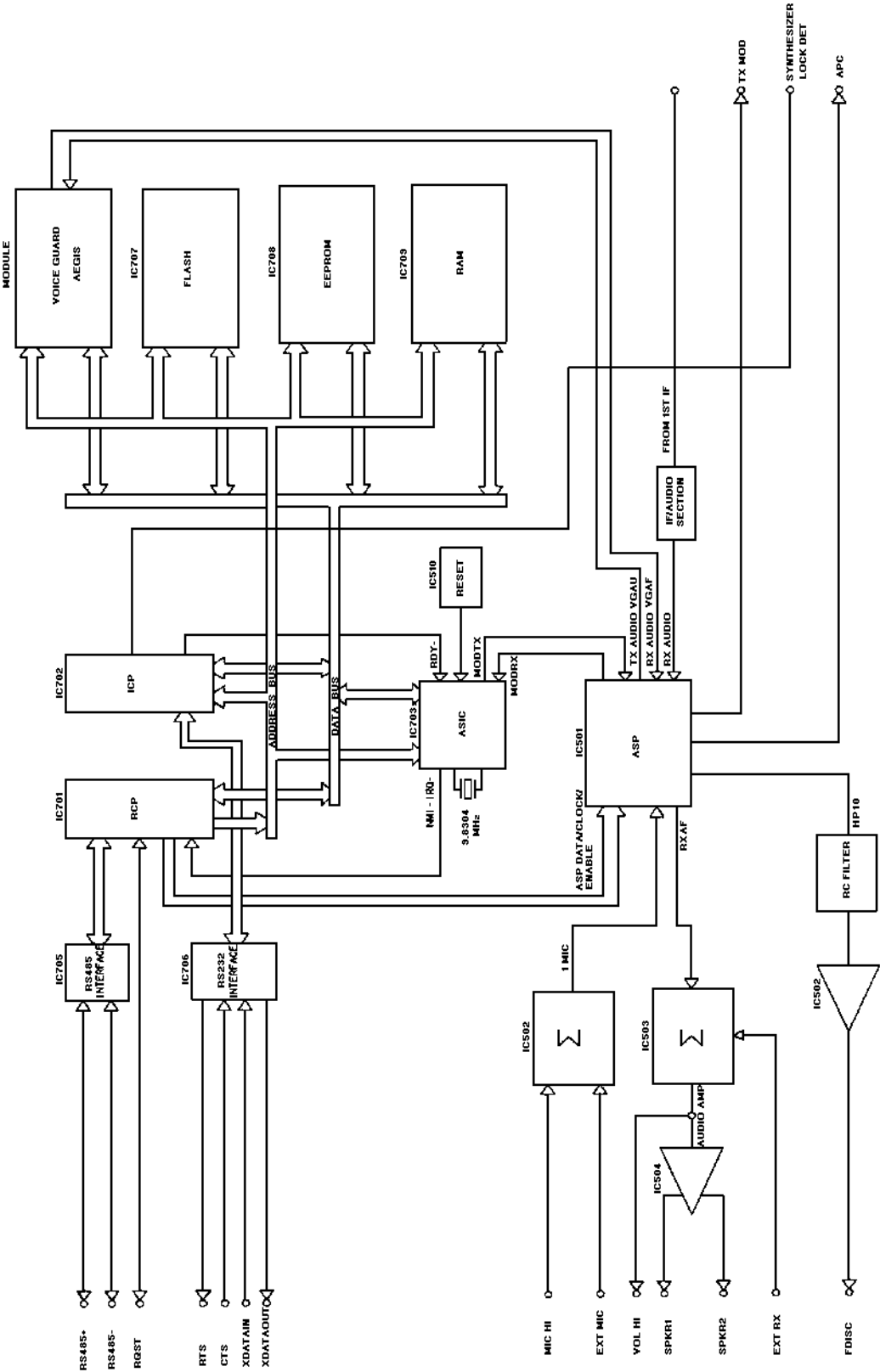


Figure 1 - Logic Section Block Diagram

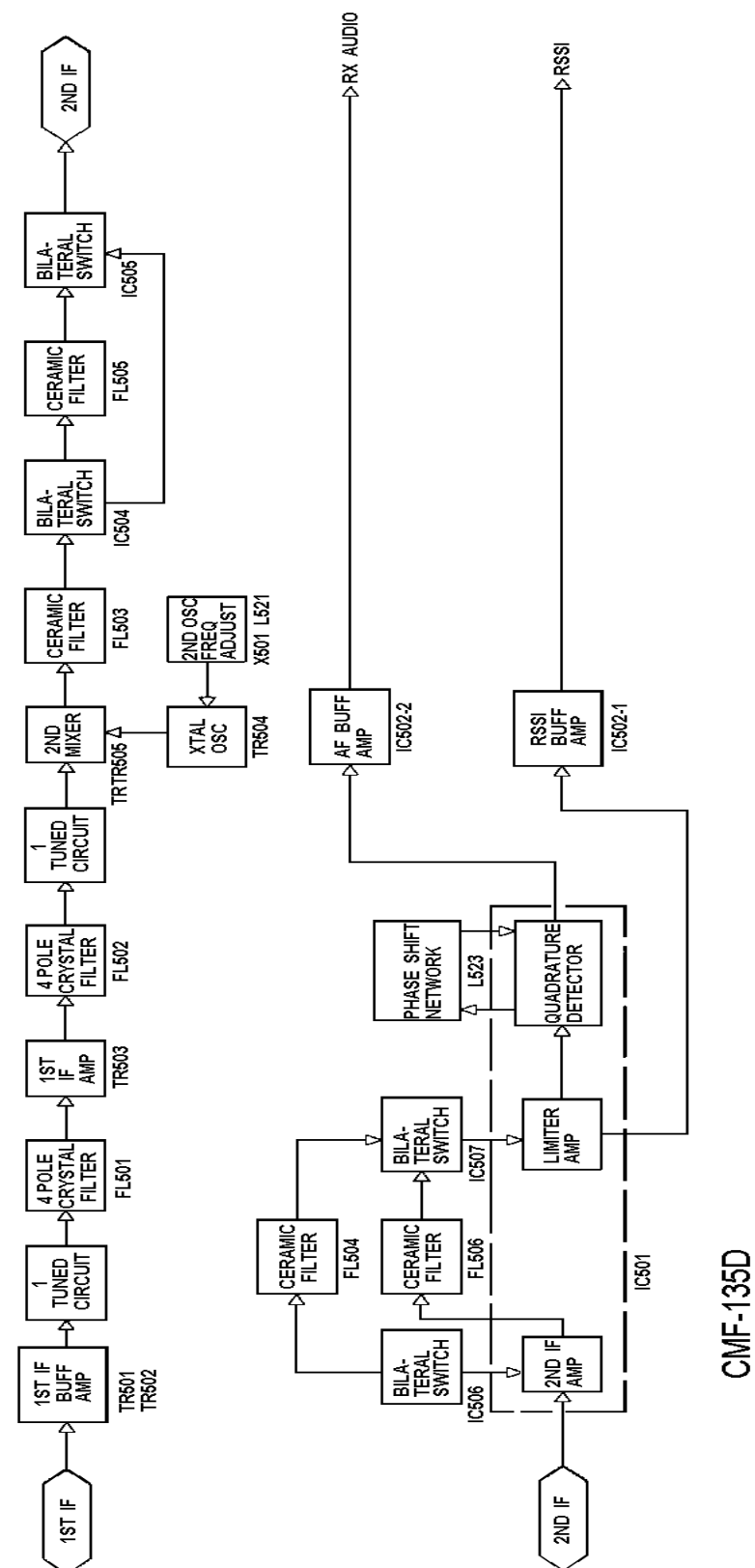


Figure 2 - IF Section Block Diagram

### Voltage Regualtors (IC606, IC607) (IC605, IC608, IC609)

Voltage regulators IC606 and IC607 each generate a 5 Vdc for the Control Board. Voltage regulators IC605, IC608 and IC609 each generate a 9 Vdc for the Control Board and Voice Guard Adapter Module.

### Audio Amplifier (IC604)

The audio amplifier is located between the audio processor and the speaker. Amplifier IC604 amplifies the output signal of the ASP (IC601) to the level adequate for driving the speaker.

### Audio Signal Processor (ASP ) (IC601)

The audio process consists of a one-chip IC accommodating almost all of the audio functions. The audio functions are under control of the microcomputer in compliance with the function of the radio unit.

The functions of the audio processor are as follows:

- Rx Audio process with Tone Reject Filter, De-emphasis and Programmable Attenuator.
- Data Limiting
- CG/DCG filtering and limiting
- Noise Squelch filtering and detecting
- 8 bits D/A Converter with sample and hold
- Tx audio process with microphone amplifier, pre-emphasis, deviation limiter, summing amplifier, post limiter filter and programmable attenuator
- Data signal filtering
- Two 6 bits programmable divider for clock and alert tone

All of these functions are made up of switched capacitor filters, amplifiers and timing logic. The timing for this logic is derived from the 4.9152 MHz clock generator (ASIC).

RS-485 (IC705)

This is a high speed differential TRI-STATE bus/line transceiver designed to meet the requirements of EIA standard RS-485 specification. The IC705 is located between the Radio Unit and the Control Unit.

RS-232 (IC706)

This IC consists of line drivers/receivers designed to meet the requirements of EIA standard RS-232 specifications. The IC706 is located between the radio unit and the ORCC.

### Comparator Circuit (IC610)

This is an active low reset IC which includes a delay time generating circuit. Delay time can be set up by externally using a capacitor and a resistor. The function of this IC is to accurately reset the system after detecting voltage at the time of switching power on and instantaneous power off.

### Option and Remote Control Connector (ORCC)

The ORCC is located on the rear of the radio and is used for options and accessories when Control Unit and Radio Unit are directly attached and for remote control in all other configurations. The ORCC allows various kinds of external equipment connections to be made. External equipment connecting signals are as follows:

PIN	SIGNAL	PIN	SIGNAL
1	SUP GND	20	RTS
2	XDATA IN	21	INP1
3	XDATA OUT	22	OUT1
4	RS485+	23	INP2
5	RS485-	24	IGN A+
6	CTS	25	SW +
7	GND	26	HKSW
8	FPROG	27	EXTMIC
9	OUT2	28	EXTRX
10	IGN SEN	29	FDISC
11	MIC HI	30	EXTALO
12	ALO	31	CUTST
13	VOL HI	32	SPARE
14	CTL ON	33	SPARE
15	XTONENC	34	SPARE
16	XTONEDEC	35	SDATA
17	RQST	36	SONOFF
18	SPKR1	37	HORNRING
19	SPKR2		

**IF SECTION (CMF-135D)**

**1st IF**

The 45.1 MHz 1st IF output signal is coupled from the output of the first mixer circuit, located on the Synthesizer/Receiver/IF board, through 30-pin connector P501-1 and capacitor C501 to the source input of buffer amplifier Junction Field Effect Transistors (JFET) TR501 and TR502. This input can be monitored at test point TP1. The output of TR501 and TR502 is coupled through inductor L502 to 4-pole crystal band-pass filter FL501. The highly-selective crystal filters FL501-1 and FL502-2 provide the first part of receiver IF selectivity. The output of the filters is coupled through the impedance matching network consisting of inductor L502 and capacitors C504 and C505 to the base of 1st IF amplifier transistor TR503. The crystal filter output of FL501 is applied to

the base of 1st IF amplifier transistor TR503. This amplified signal is taken from the collector of TR503 through an impedance matching network consisting inductor L505, capacitor C506 and resistor R507 that matches the amplifier output to the input of 4-pole crystal filters FL502-1 and FL502-2 which provides the second part of receiver IF selectivity. The output of the crystal filters is coupled through an impedance-matching network consisting of inductor L507, capacitor C508, resistor R508 and coupling capacitor C509 to the base of 2nd IF amplifier transistor TR505.

2nd Mixer

The 45.1 MHz IF input is applied to transistor TR505 and mixed with a 44.645 MHz frequency supplied by a crystal oscillator circuit consisting of X501 and oscillator transistor TR504. Variable inductor L521 sets the frequency of the oscillator circuit. This signal can be monitored at test point TP5.

2nd IF And Detector

The output of the 2nd mixer is coupled to the input of 4-pole ceramic filter FL503 which provides 455 kHz 2nd IF selectivity. The 455 kHz IF output of ceramic filter FL503 is coupled to the bandwidth selector circuit consists of IC504-1, IC504-2, IC505-1 and IC505-2 which are controlled by a microprocessor output signal 12.5 kHz/ 25 kHz through switching transistor TR506 and TR507. When 25 kHz (wide band) is selected, IC504-1 and IC505-1 are turned on. The output of the ceramic filter FL503 is coupled through capacitors C580 and C553 to the input of IC501, pin 3. When 12.5 kHz (narrow band) is selected, IC504-2 and IC505-2 are turned on. The output of the ceramic filter FL503 is coupled through 4-pole ceramic filter FL505 to pin 3 Limiter/FM Detector IC501. The IF signal is amplified internal to IC501 then applied to the

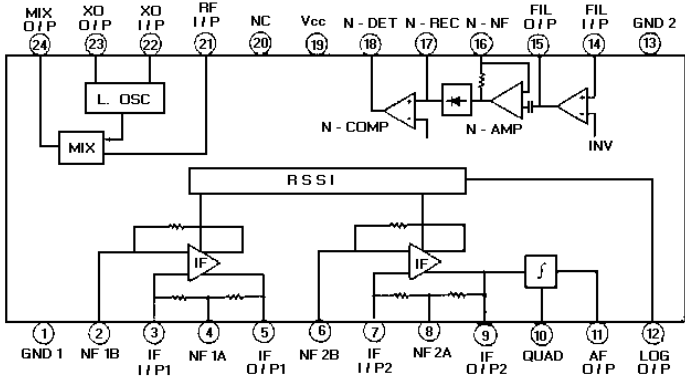
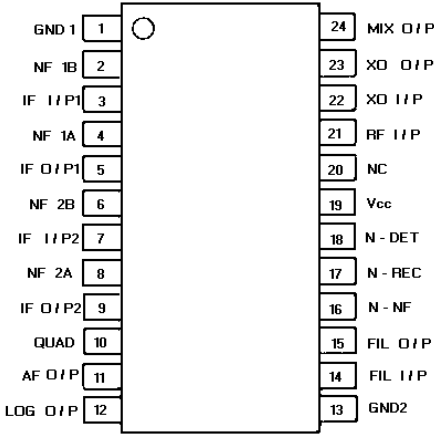
bandwidth selector circuit consisting of IC506-1, IC506-2, IC507-1 and IC507-2 which are controlled by a microprocessor output signal 12.5 kHz/ 25 kHz through switching transistor TR506 and TR507. When 25 kHz (wide band) is selected, IC506-1 and IC507-1 are turned on. The output of the IC501-5 is coupled through ceramic filter FL504 which provides additional 455 kHz IF selectively to the input of IC501, pin 7.

When 12.5 kHz (narrow band) is selected, IC504-2 and IC505-2 are turned on. The output of the IC501-5 is coupled through ceramic filter FL506 which provides additional 455 kHz IF selectivity to the input of IC501, pin 7 (refer to IC DATA for IC501). The 2nd IF signal is amplified and limited internal to IC501. Inductor L253 shifts the IF signal by 90° and applies it to the internal FM detector. The FM detector compares the shifted IF signal to the internal IF signal to recover the audio modulation.

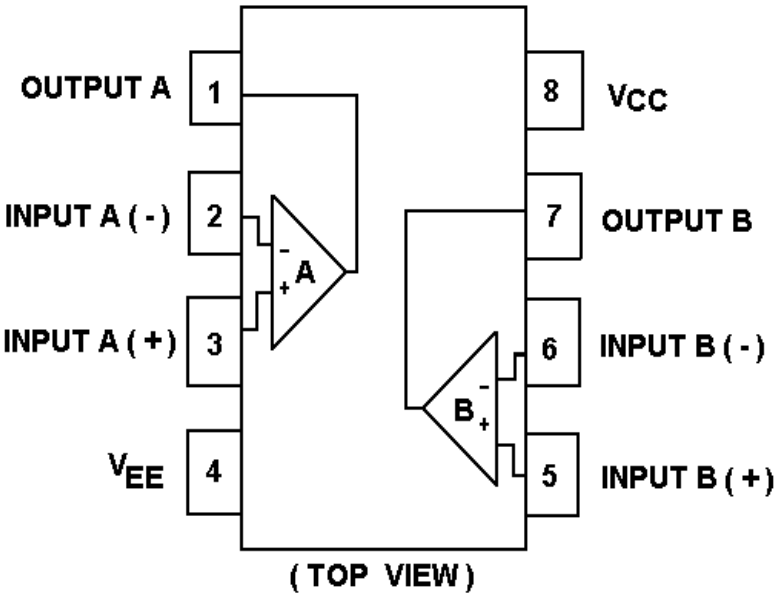
The audio output of the operational amplifier internal to IC501 is applied to the input of buffer IC502-2. Amplitude of buffer amplifier IC502-2 is reduced by 6 dB when 25 kHz (wide band) is selected by switching transistor TR508. The AUDIO output of IC502-2 is applied to the System Control Logic circuit. This signal can be monitored at test point TP4. The output on pin 12 of IC501 is applied to the input of amplifier buffer IC502-1. The output of IC502-1 provides a Receiver Signal Strength Indicator (RSSI) signal also sent to the System Control Logic circuit. This signal can be monitored at test point TP3.

9 Volt Regulator

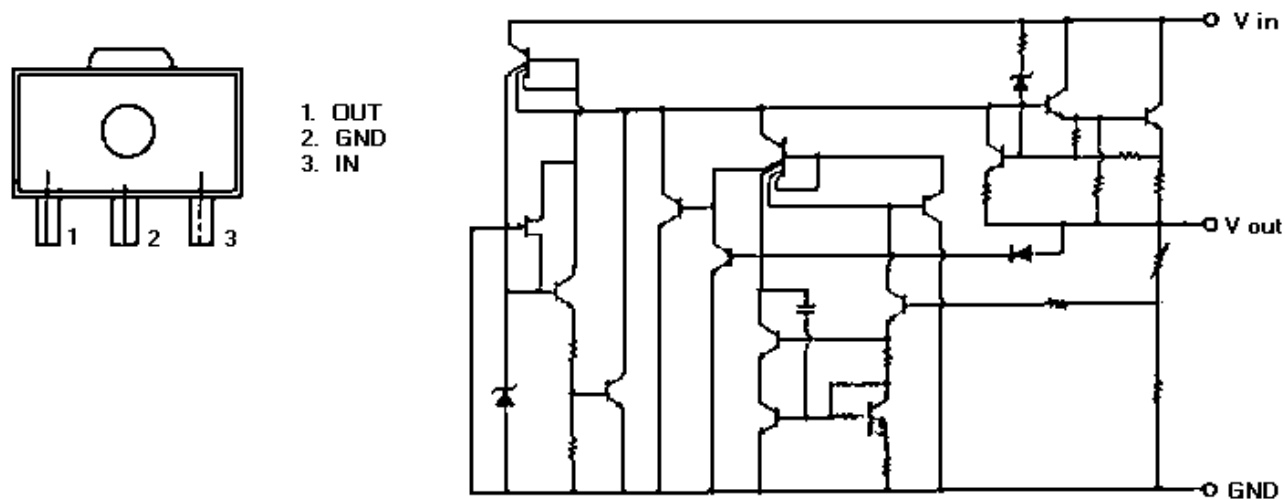
The 9-volt regulator circuit powers the IF circuits of CMF-135 and consists of regulator IC503 and filter capacitors C570, C571, C572, and C573. An input voltage of +13.8 Vdc is applied to the input of IC503. This input is monitored at test point TP2.



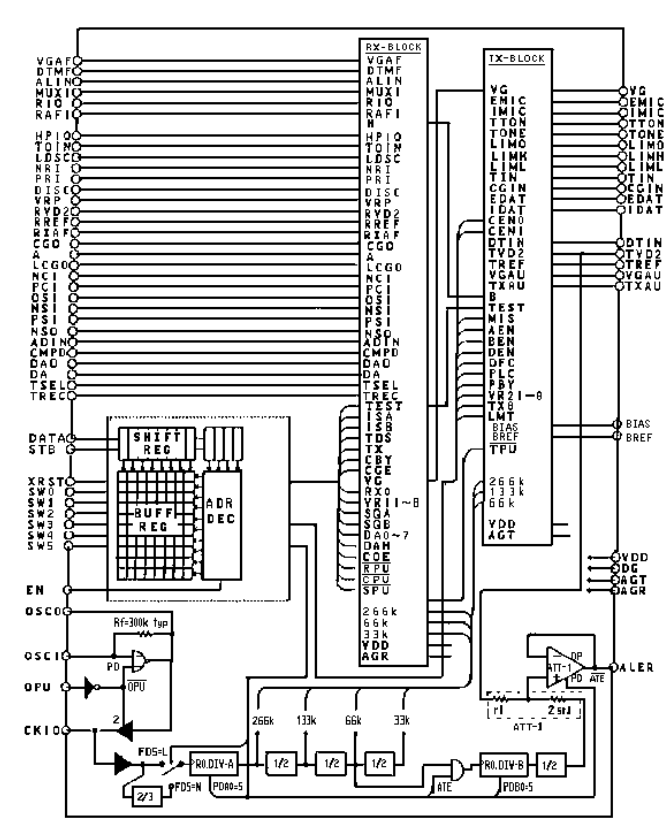
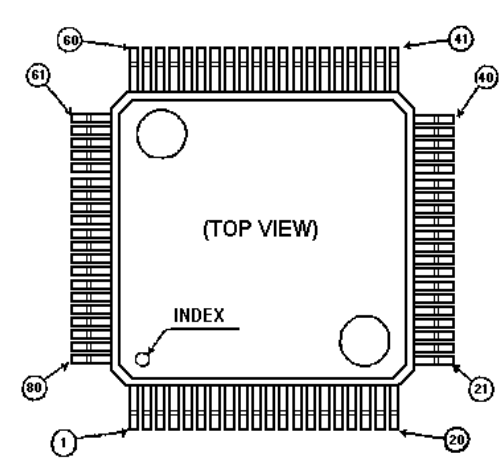
Linear, Dual Operational Amplifier IC502



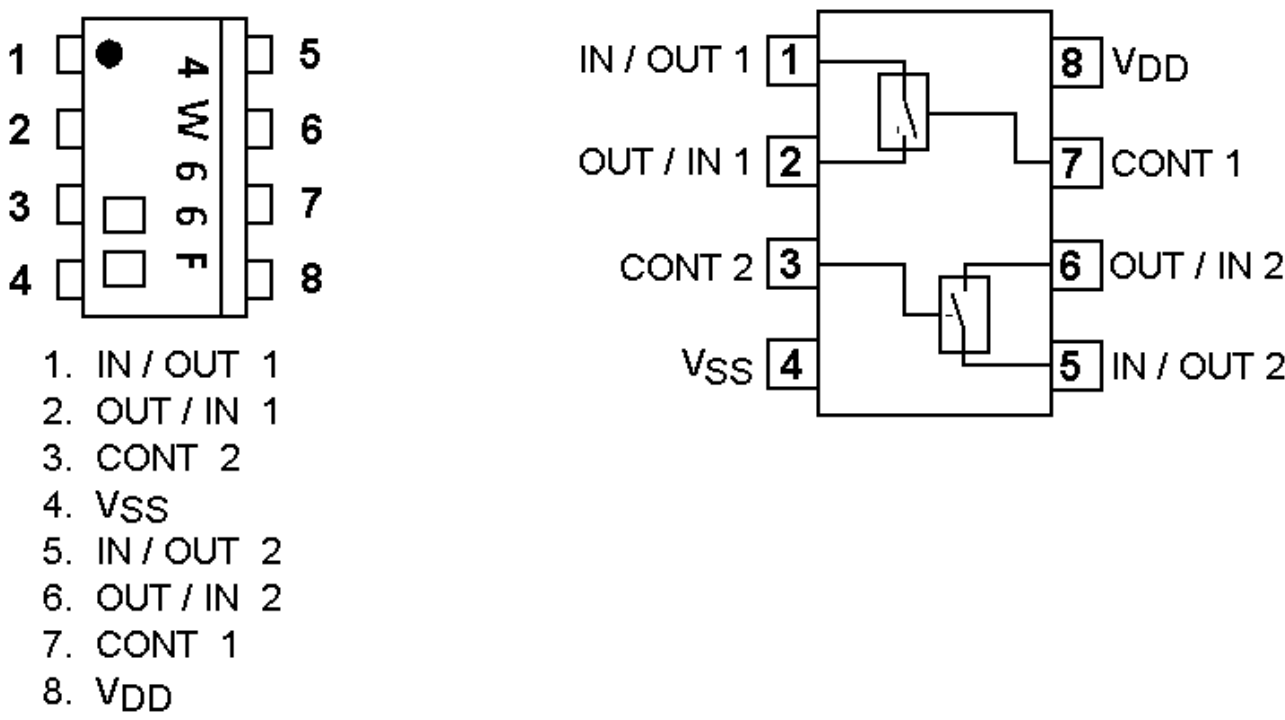
Linear, Positive Voltage Regulator IC503



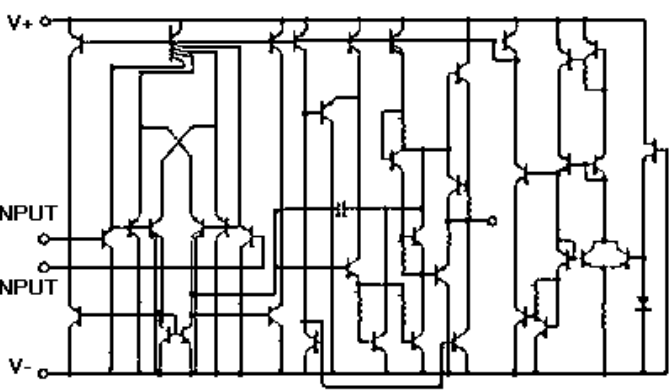
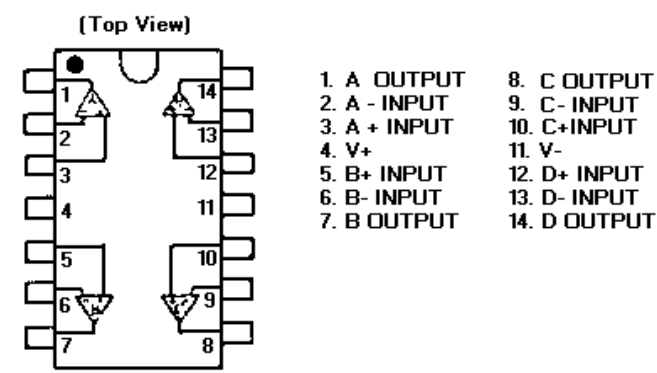
Audio Signal Processor IC601



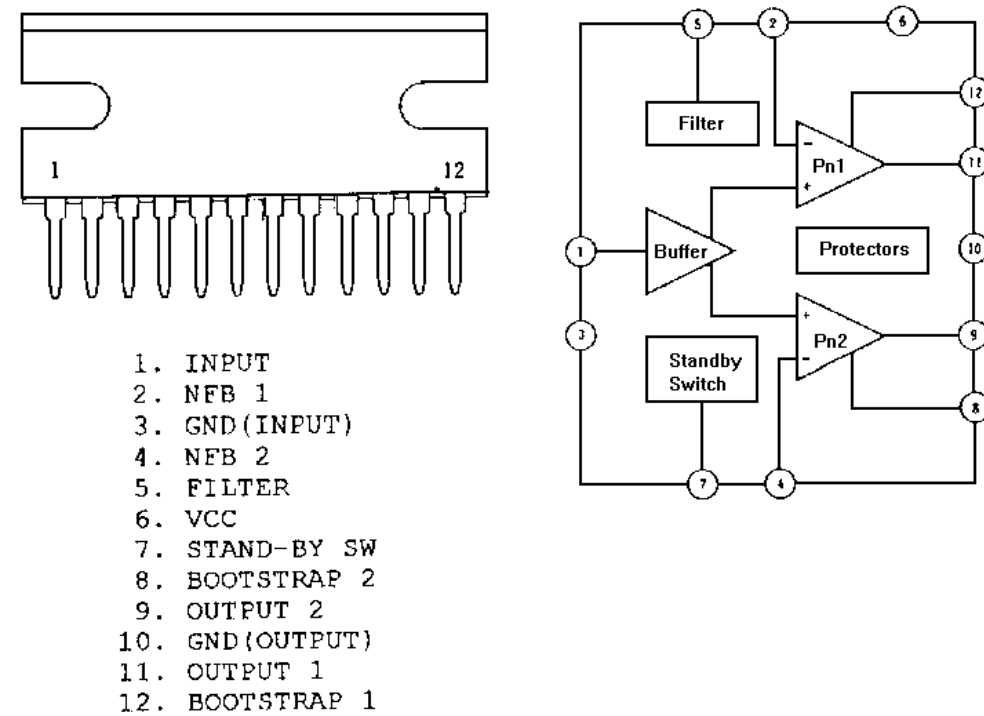
Linear Bi-Lateral Switch IC504 - IC507



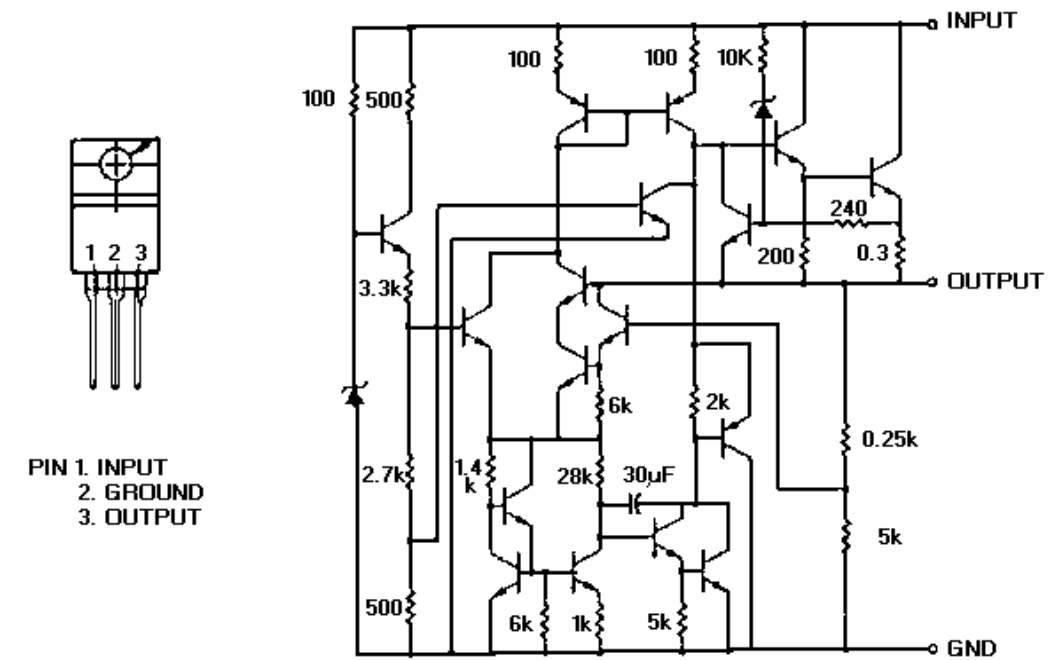
Linear Audio Amplifier IC602, IC603



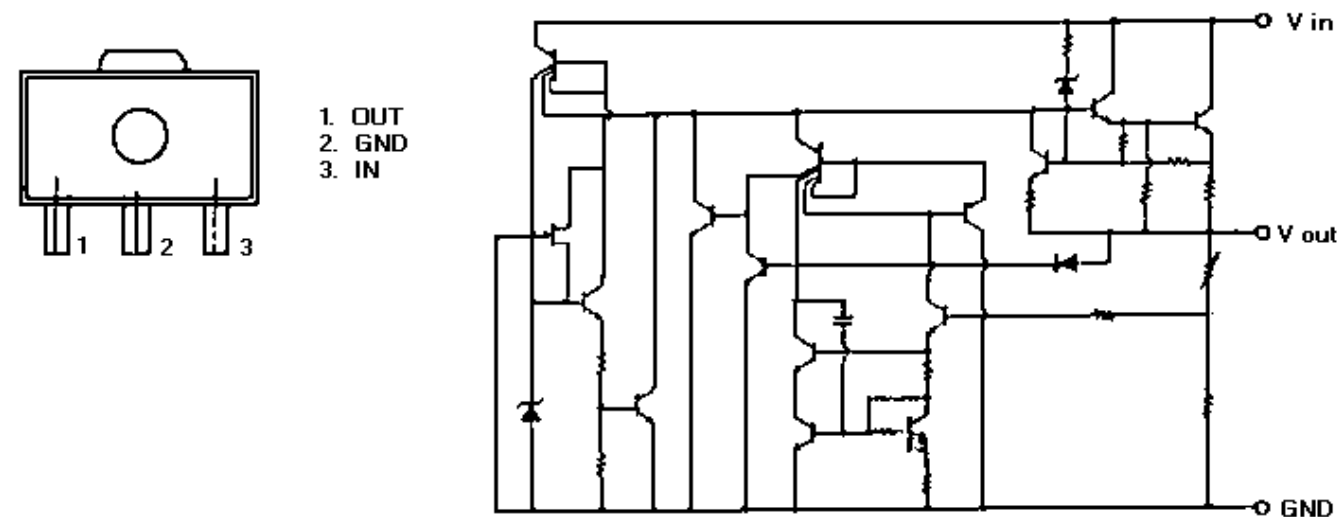
Audio Frequency Power Amplifier IC604



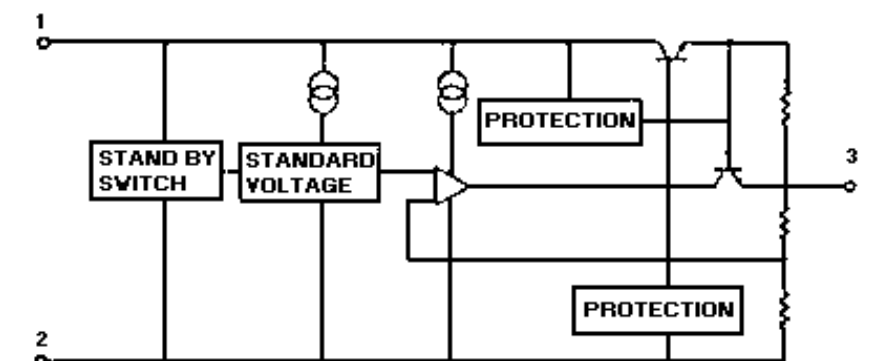
Linear: Positive Voltage Regulator IC606



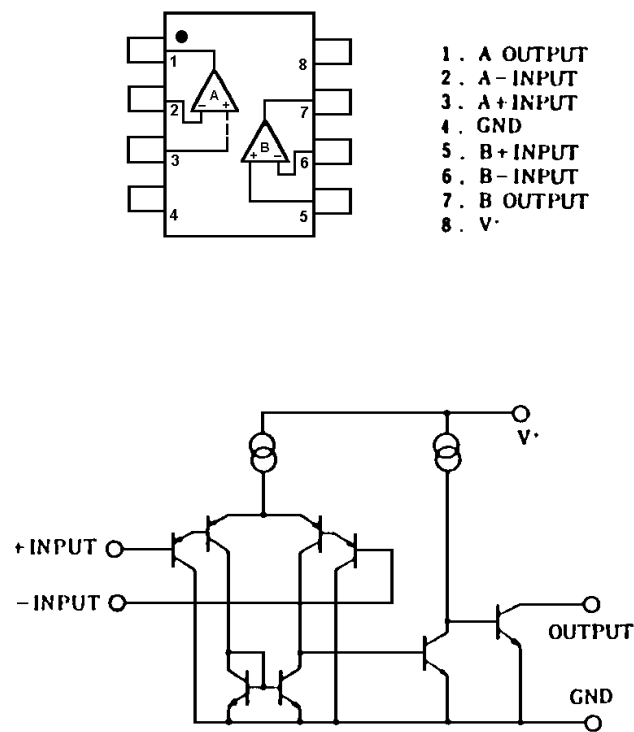
Linear: Positive Voltage Regulator IC605, IC609



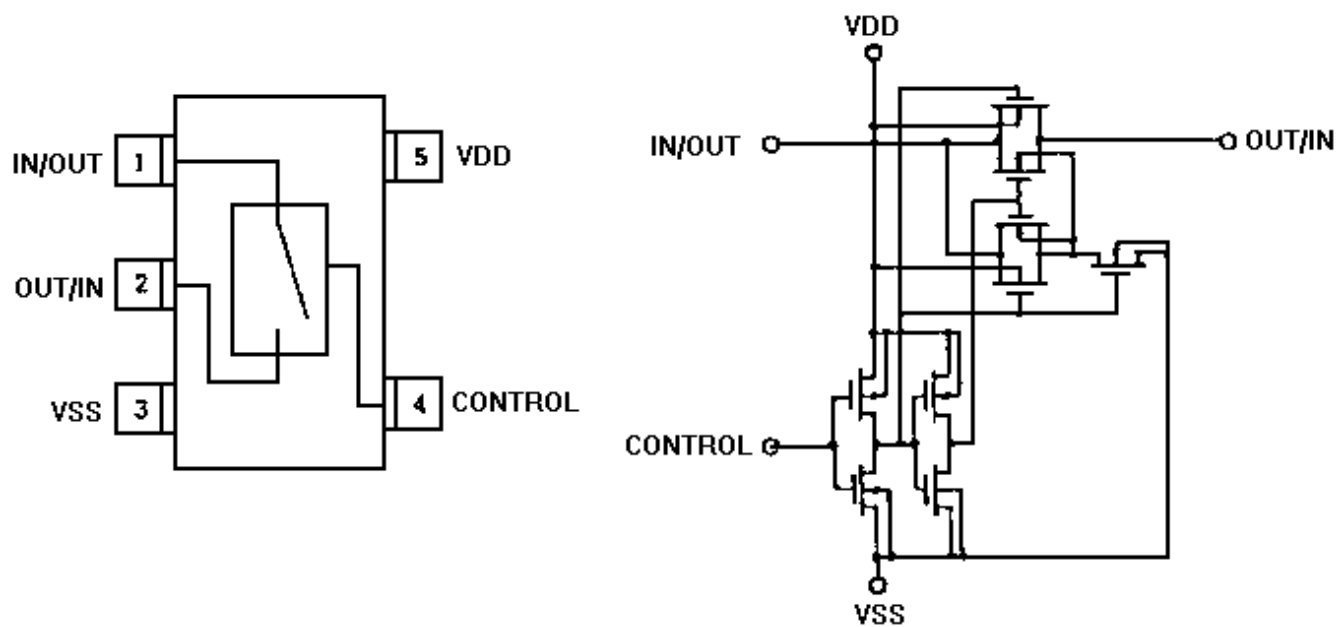
Linear: Positive Voltage Regulator IC607, IC608



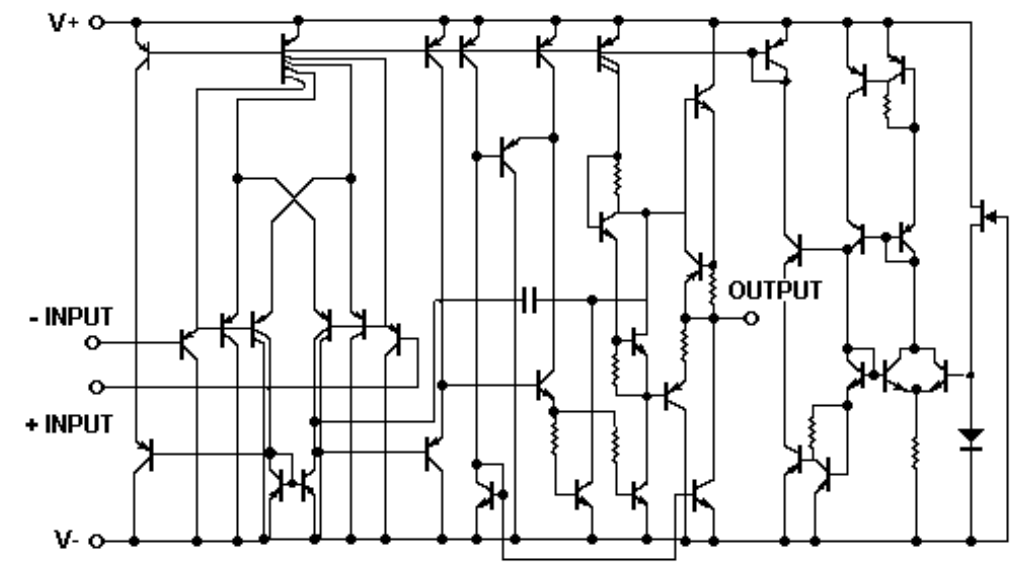
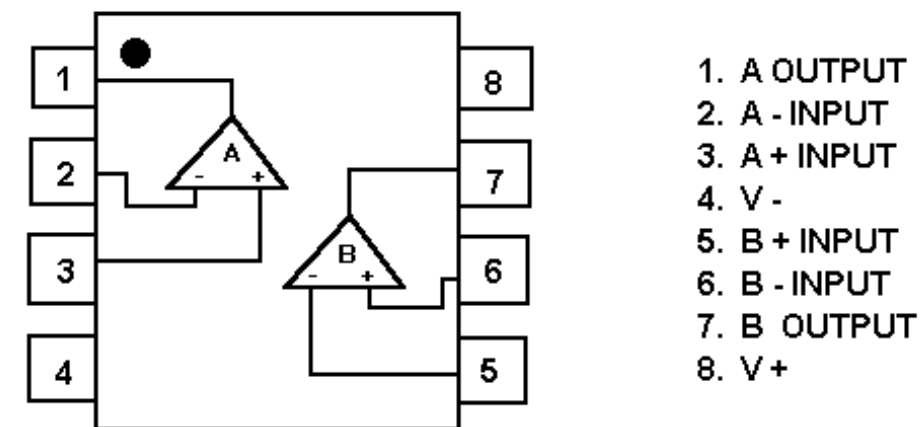
Comparator IC610



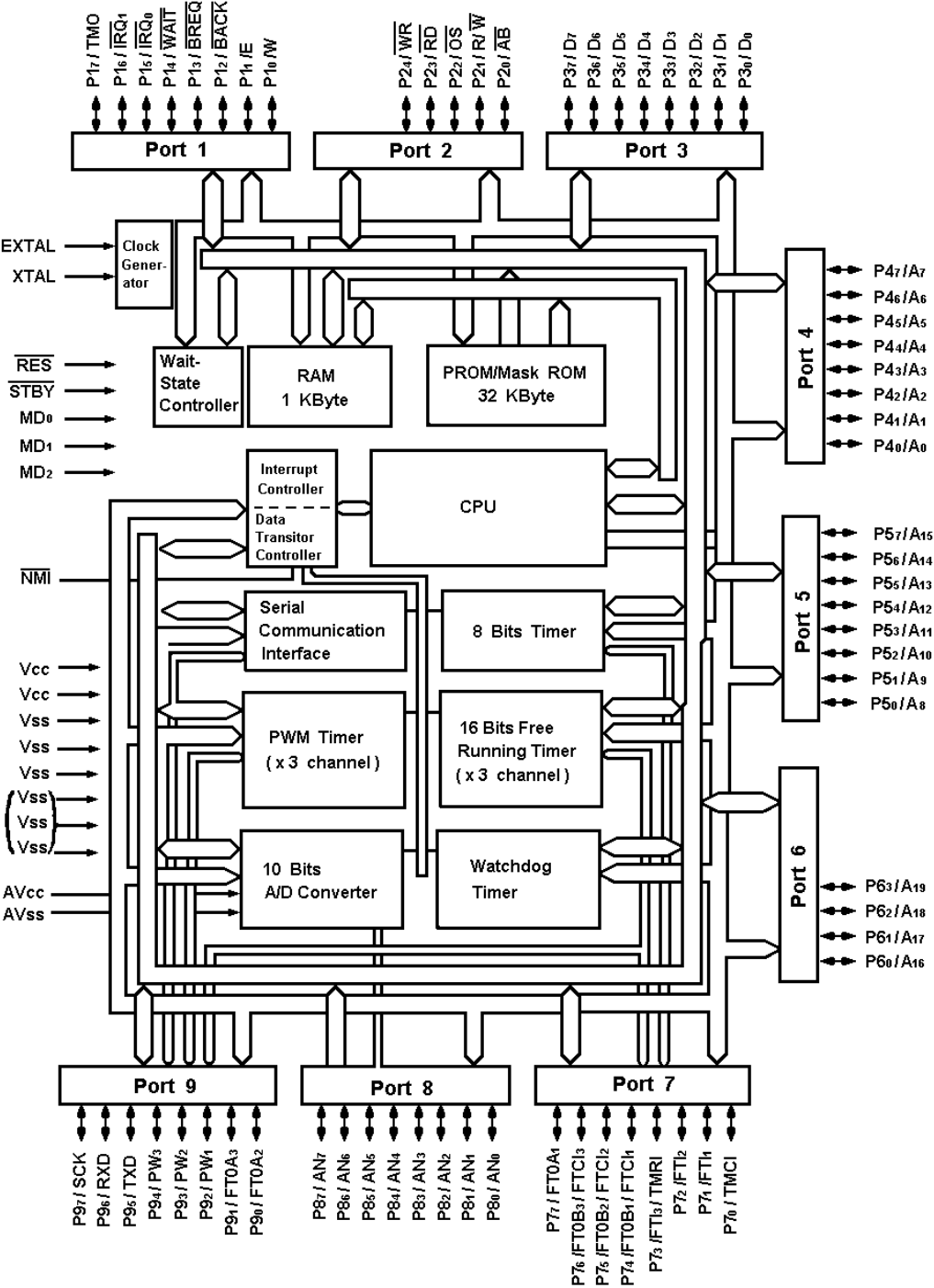
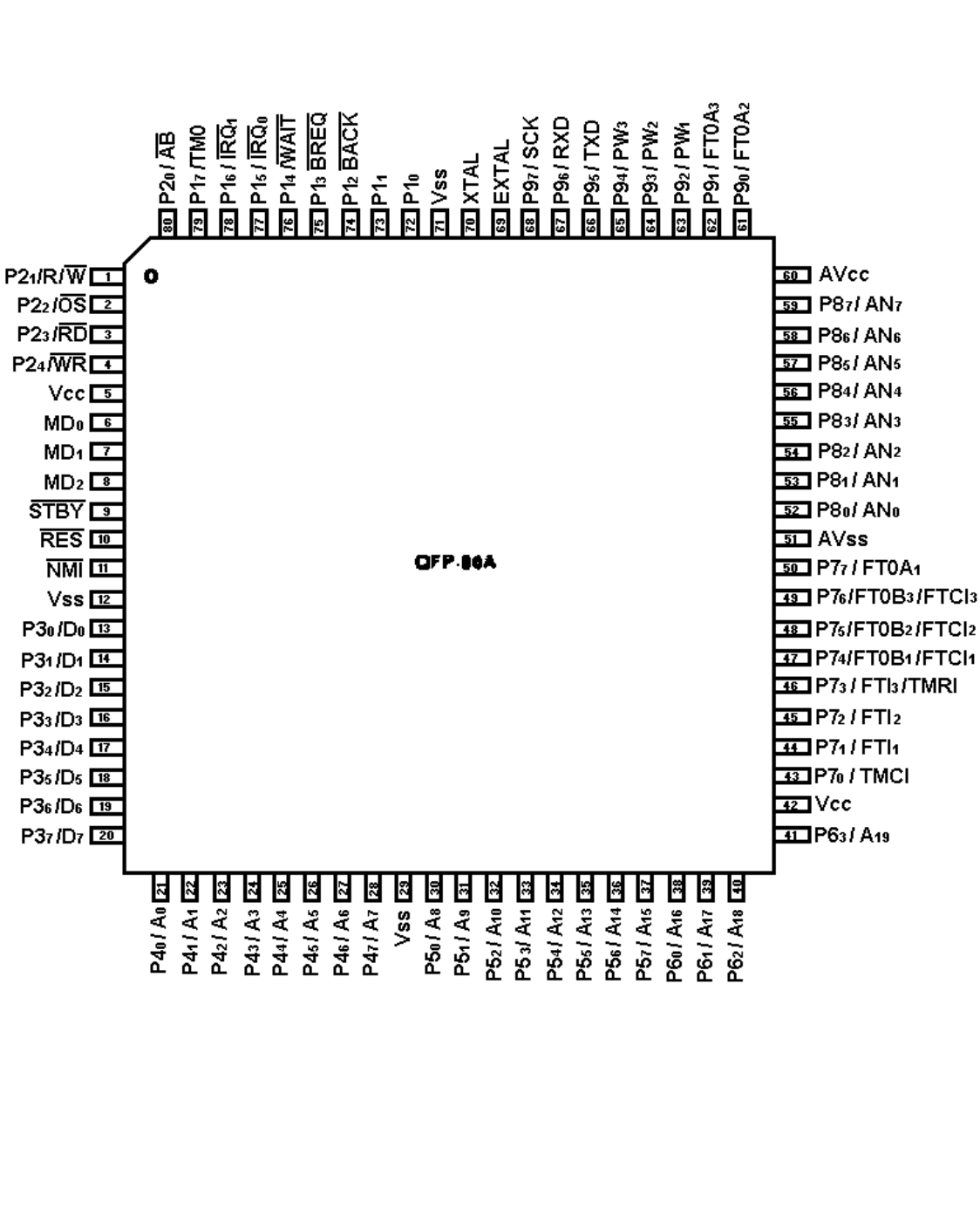
Bilateral Switch IC611, IC612, IC613



Operational Amp IC614



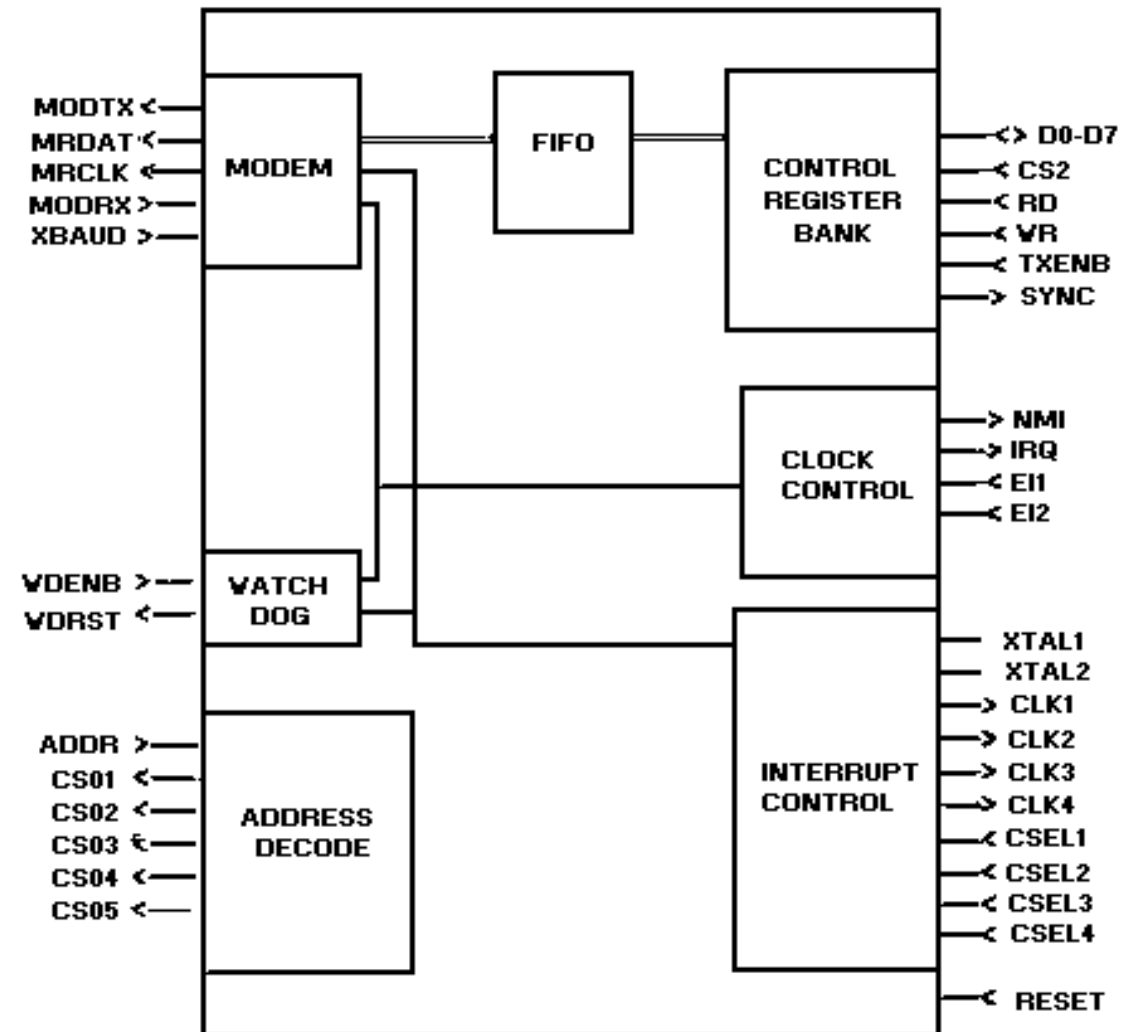
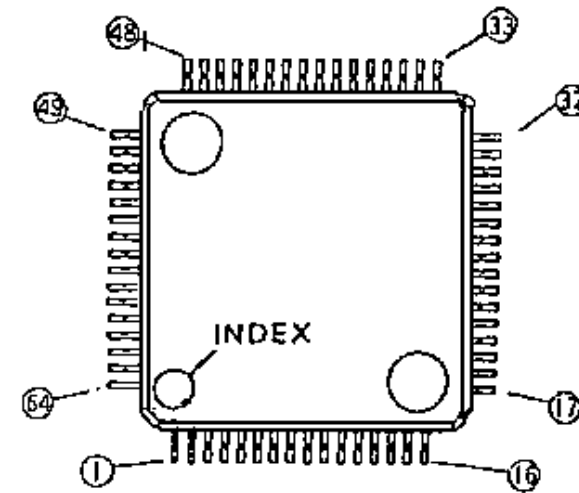
Central Processing Unit IC701



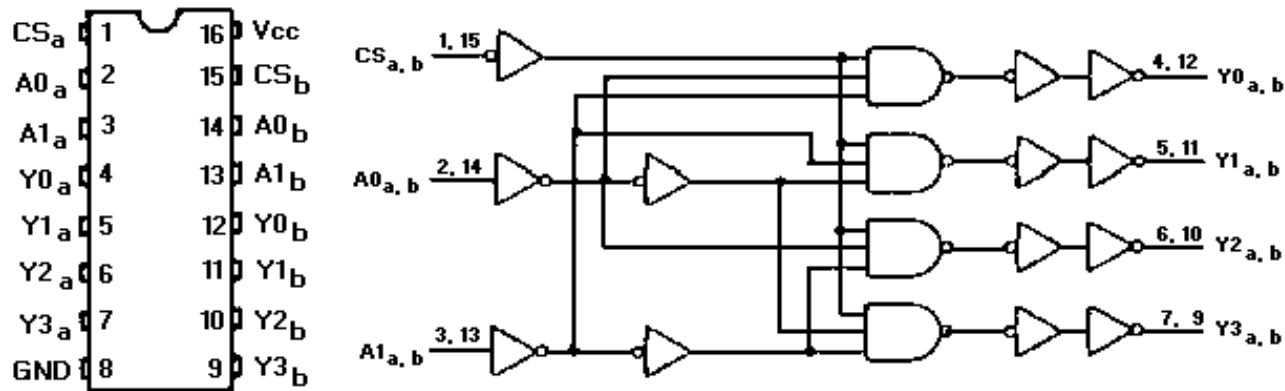
\*CP-84 and CO-84 only



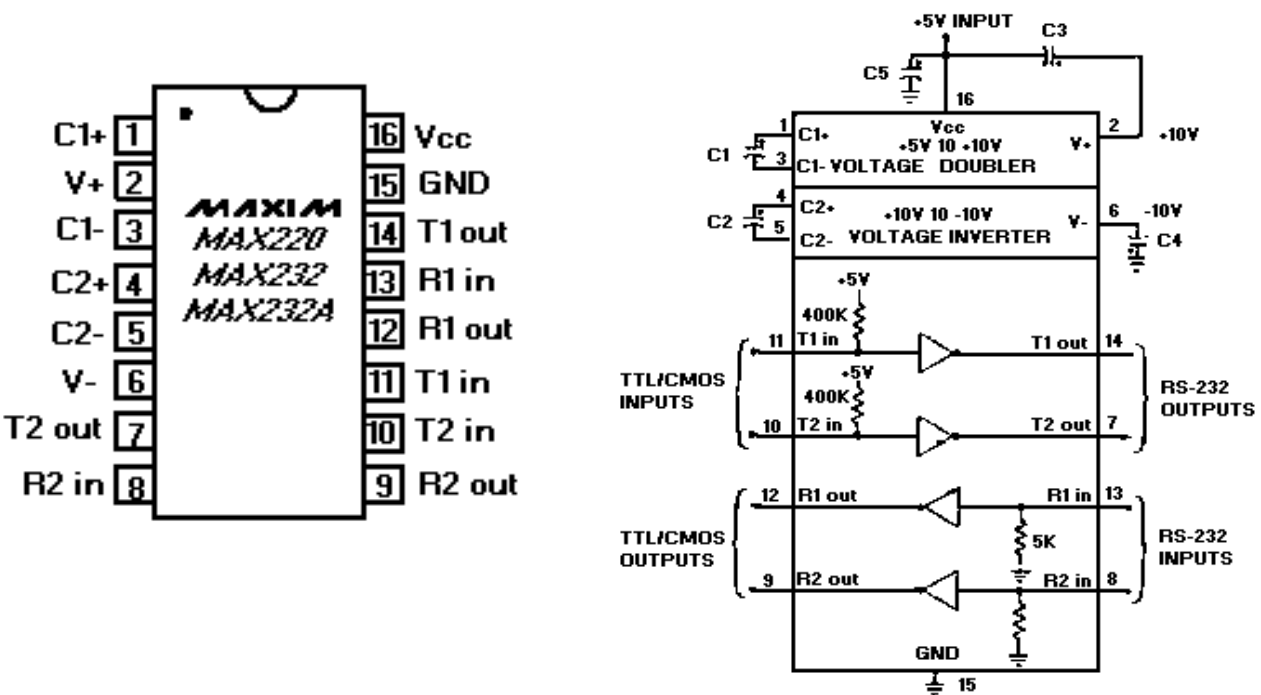
## ASIC IC703



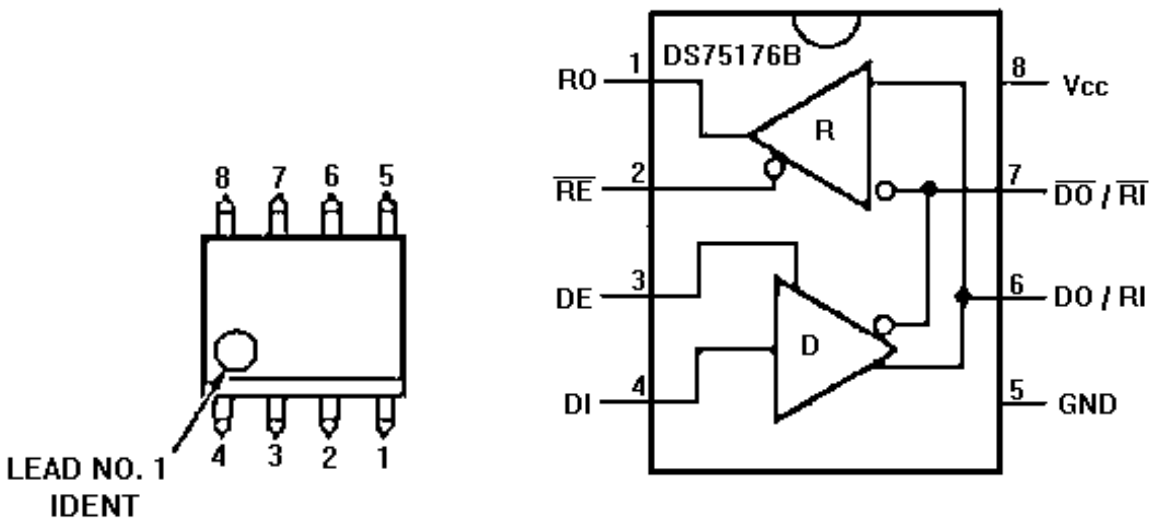
Decoder IC704



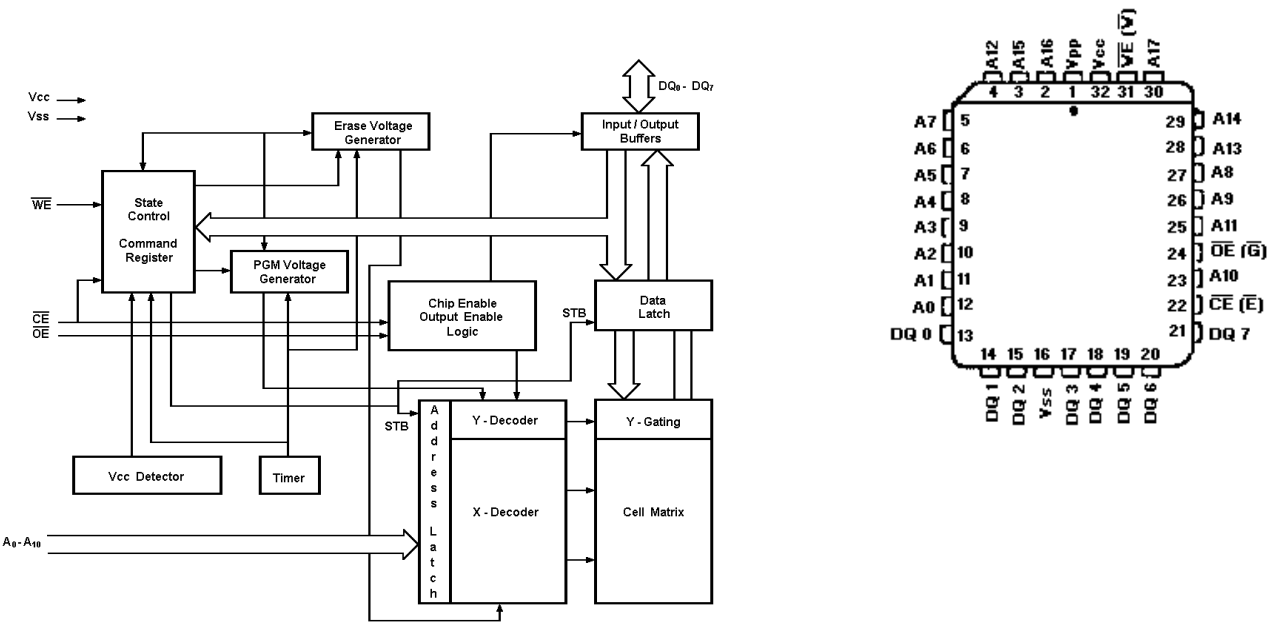
RS-232 Driver/Receiver IC706



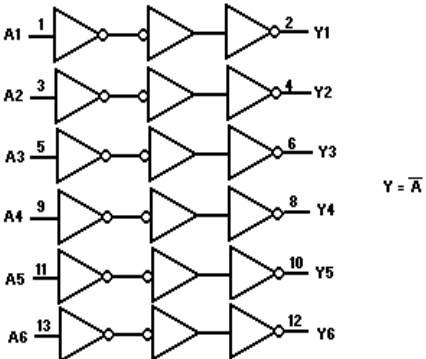
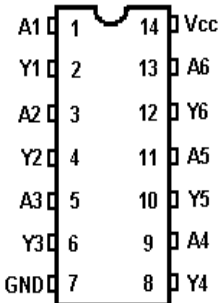
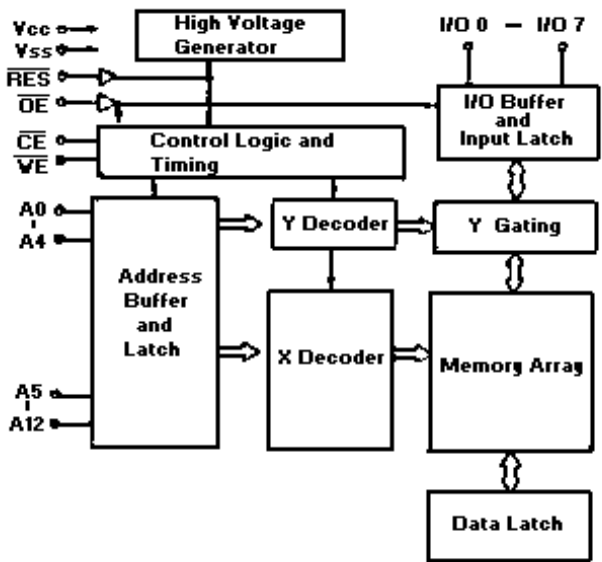
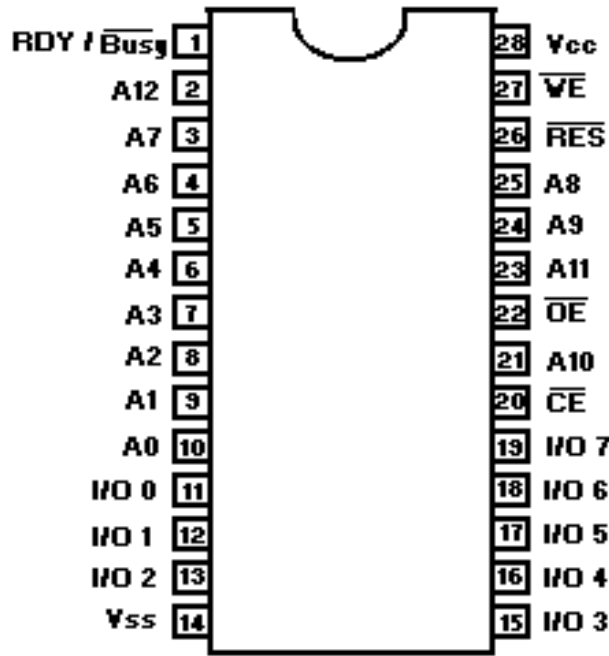
RS-485 Driver/Receiver IC705



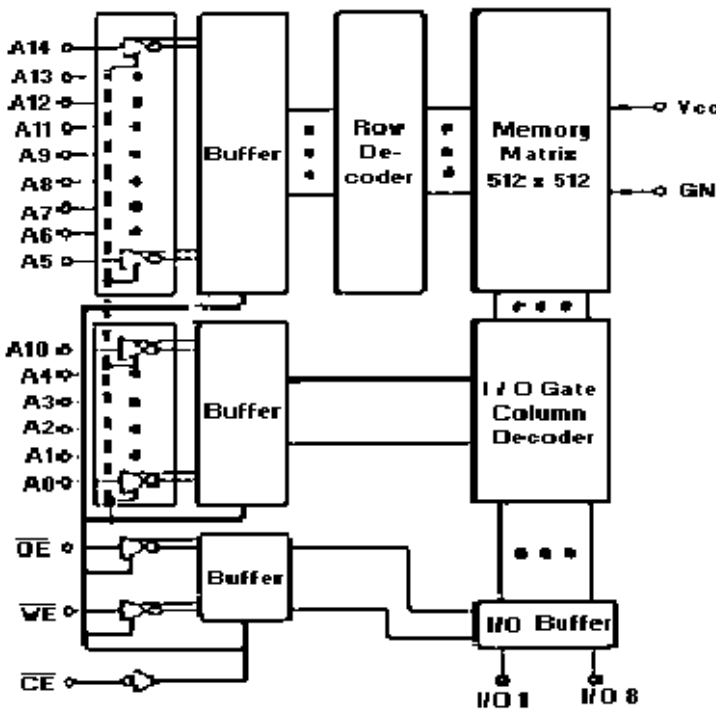
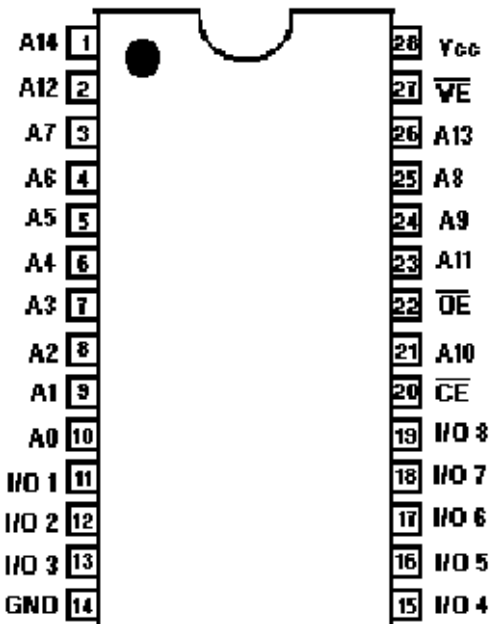
Flash Memory IC707



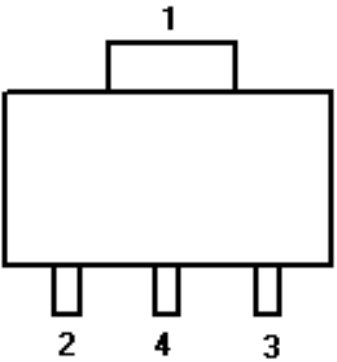
EEPROM IC708



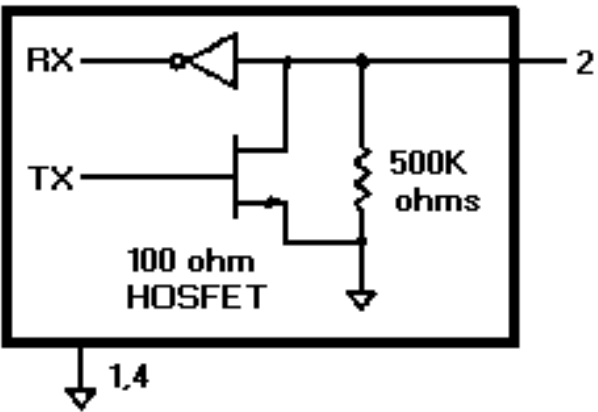
RAM IC709



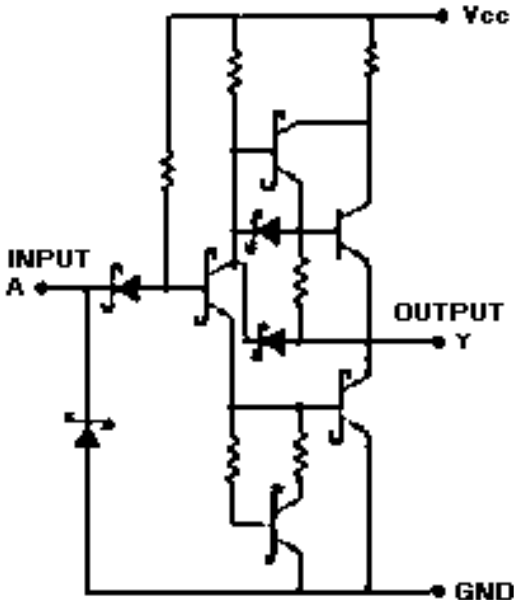
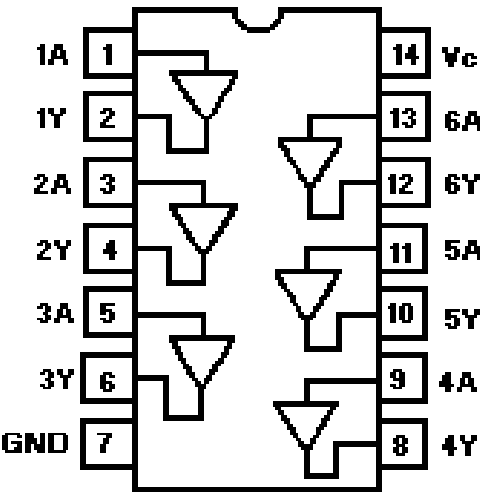
Silicon Seral Number IC712



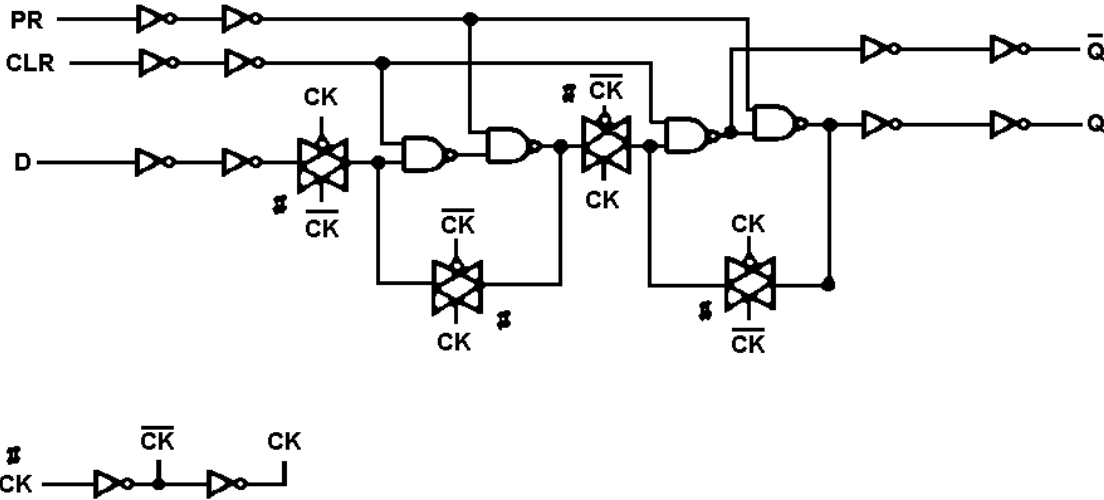
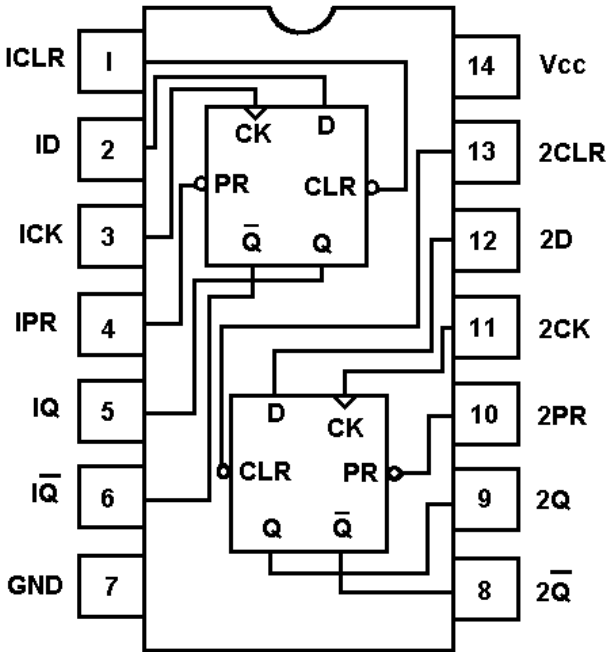
- 1. GND
- 2. DATA (DG)
- 3. NC
- 4. GND



Inverter IC713



Circuit IC714



PARTS LIST  
LOGIC/IF BOARD  
LOGIC SECTION  
CMC-682D  
(Used in P101, P102)

SYMBOL	PART NO.	DESCRIPTION
		----- CAPACITORS -----
C601	NOTE: Parts listed are for reference only. Refer to Service Section for serviceable	Ceramic: 0.01 $\mu$ F $\pm$ 10%, 50 VDC, temp coef $\pm$ 15%.
C602		Ceramic: 1 $\mu$ F +80%/-20%, 16 VDCW, temp coef +22%/-82%.
C603		Ceramic: 220 pF $\pm$ 5%, 50 VDCW, temp coef 0 $\pm$ 30 PPM/ $^{\circ}$ C.
C604		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW.
C605		Ceramic: 0.01 $\mu$ F $\pm$ 10%, 50 VDC, temp coef $\pm$ 15%.
C606		Tantalum: 1 $\mu$ F $\pm$ 20%, 16 VDCW.
C607		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C609		
C610		Tantalum: 1 $\mu$ F $\pm$ 20%, 16 VDCW.
C611		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C612		Tantalum: 3.3 $\mu$ F 20%, 16 VDCW.
C613		Tantalum: 1 $\mu$ F $\pm$ 20%, 16 VDCW.
C614		Tantalum: 0.33 $\mu$ F $\pm$ 20%, 35 VDCW.
C615		Ceramic: 100 pF 5%, 50 VDCW, temp coef 0 $\pm$ 30 PPM/ $^{\circ}$ C.
C616		Ceramic: 1 $\mu$ F +80%/-20%, 16 VDCW, temp coef +22%/-82%.
C617		Tantalum: 0.33 $\mu$ F $\pm$ 20%, 35 VDCW.
C618		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C621		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C622		
C623		Tantalum: 22 $\mu$ F $\pm$ 20%. 16 VDCW.
C624		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C626		
C627		Tantalum: 22 $\mu$ F $\pm$ 20%, 16 VDCW.
C628		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C629		
C630		Tantalum: 22 $\mu$ F $\pm$ 20%, 16 VDCW.
C631		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C632		
C633		Tantalum: 22 $\mu$ F $\pm$ 20%, 16 VDCW.
C634		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C637		
C638		Ceramic: 220 pF $\pm$ 5% 50 VDCW, temp coef 0 $\pm$ 30 PPM/ $^{\circ}$ C
C639		Electrolytic: 47 $\mu$ F $\pm$ 20%, 25 VDCW.
C640		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C641		Electrolytic: 22 $\mu$ F $\pm$ 20%, 16 VDCW.
C642		
C643		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C644		Electrolytic: 10 $\mu$ F 20%, 25 VDCW.
C645		Ceramic: 1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C646		Ceramic: 1000pF +80%/-20%, 50 VDCW temp coef +22%/-82%.
		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C647		
C649		Electrolytic: 22 $\mu$ F $\pm$ 20%, 16 VDCW.
C650		
C651		Ceramic: 0.47 $\mu$ F +80%/-20%, 25 VDCW temp coef +30%/-80%.
C652		
C653		Tantalum: 2.2 $\mu$ F $\pm$ 20%, 16 VDCW.
C654		
C655		Electrolytic: 10 $\mu$ F $\pm$ 20%, 25 VDCW.
C656		
C657		Ceramic: 0.047 $\mu$ F +80%/-20%, 50 VDCW temp coef +22%/-82%.
C658		
C659		Tantalum: 1 $\mu$ F $\pm$ 20%, 16 VDCW.
C660		
C661		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C664		
C665		Ceramic: 0.1 $\mu$ F $\pm$ 10%, 25 VDCW, temp coef $\pm$ 15%.
C666		
C667		Tantalum: 1 $\mu$ F $\pm$ 20%, 16 VDCW.
C670		Ceramic: 3300 pF $\pm$ 10%, 50 VDCW, temp coef 15%.

SYMBOL	PART NO.	DESCRIPTION
C671 and C672 C673 C674 and C675 C677 and C678		Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.
C701 thru C706 C707 C708 and C709 C710 C711 C712 and C713 C714 C715 thru C719 C720 thru C722 C726 and C727 C728 thru C743 C744 and C745 C746 C747		Ceramic: 330 pF $\pm$ 5%, 50 VDCW, temp coef 0 $\pm$ 30 PPM/ $^{\circ}$ C. Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +20%/-82%.  Ceramic: 100 pF $\pm$ 5%, 50 VDCW, temp coef 0 $\pm$ 30 PPM/ $^{\circ}$ C.  Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.  Ceramic: 47 pF $\pm$ 5%, 50 VDCW, temp coef 0 $\pm$ 30 PPM/ $^{\circ}$ C. Ceramic: 12 pF $\pm$ 0.25 pF, 50 VDCW, temp coef 0 $\pm$ 30 PPM/ $^{\circ}$ C.  Ceramic: 47 pF $\pm$ 5%, 50 VDCW, temp coef 0 $\pm$ 30 PPM/ $^{\circ}$ C. Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%. Ceramic: 100 pF $\pm$ 5%, 50 VDCW, temp coef 0 $\pm$ 30 PPM/ $^{\circ}$ C.  Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%. Tantalum: 1 $\mu$ F $\pm$ 20%, 16 VDCW.  Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.  Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.  Ceramic: 100 pF $\pm$ 5%, 50 VDCW, temp coef 0 $\pm$ 30 PPM/ $^{\circ}$ C.  Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%.  Ceramic: 1000 pF $\pm$ 10%, 50 VDCW, temp coef $\pm$ 15%. Ceramic: 1000pF +80%/-20%, 50 VDCW temp coef +22%/-82%.  Ceramic: 0.01 $\mu$ F $\pm$ 5%, 50 VDCW, temp coef 0 $\pm$ 30 PPM/ $^{\circ}$ C. Ceramic: 0.1 $\mu$ F +80%/-20%, 25 VDCW, temp coef +22%/-82%. Ceramic: 47 pF $\pm$ 5%, 50 VDCW, temp coef 0 $\pm$ 30 PPM/ $^{\circ}$ C. Ceramic: 0.01 $\mu$ F $\pm$ 10%, 50 VDC, temp coef $\pm$ 15%.
C748 C749 C750 C751		----- DIODES ----- POWER Supply rectification diode: sim to SANKEN SFPM-64V.
CD601 and CD602 CD604 and CD605 CD606 CD701 thru CD705 CD709 and CD710 CD711		Silicon fast recovery (2 diodes in series):sim to TOSHIBA ISS300.  Zener. 900mW 22 V: sim to Hitachi HZF12. Silicon fast recovery (2 diodes in series):sim to TOSHIBA ISS302.  Silicon fast recovery (2 diodes in series):sim to TOSHIBA ISS302.  Silicon fast recovery (2 diodes in series):sim to TOSHIBA ISS300. Zener. 900mW 22 V: sim to Hitachi HZF12.
CX701 and CX702		EMI Filter.
F601		----- FUSES ----- Fuse 5A.
IC601 IC602 and IC603 IC604 IC605 IC606		----- INTEGRATED CIRCUITS ----- Audio Signal PROCESSOR. Linear Audio Amplifier: sim to NJRC3403AV.
IC607 IC608 IC609 IC610 IC611 thru IC613 IC614		AF Power Amplifier: sim to NEC UPC2500H. Linear Positive Voltage Regulator: sim to NJRC NJM78L09UA. Linear: Positive Voltage Regulator; sim to MOTOROLA MCT7805CT. Linear: Positive Voltage Regulator; sim to SANYO L78M05T. Linear: Positive Voltage Regulator; sim to SANYO L78M09T. Linear Positive Voltage Regulator: sim to NJRC NJM78L09UA. Dual Single Supply Comparator: sim to NJRC NJM2903M Bilateral Switch: sim to TOSHIBA TC4S66F.  Dual Single Supply Operational Amplifer; sim to NJRC NJM3404AV.

SYMBOL	PART NO.	DESCRIPTION
IC615 IC701 IC702 IC703 IC704 IC705 IC706 IC707 IC708 IC709 IC711 IC712 IC713 IC714		Bilateral Switch: sim to TOSHIBA TC4S66F. CPU: sim to HITACHI HD6435328RE33F. CPU: sim to HITACHI HD6433308RC27F. ASIC: sim to TOSHIBA TC24SC090AF. DECODER: Sim to MOTOROLA MC74HC139. RS485 Driver/Receiver: sim to NS AS75176. RS232 Driver/Receiver: sim to MAXIM MA232EWE. FLASH MEMORY: sim to Amp AM29F040. EEPROM: sim to HITACHI HN58C66FP. RAM: sim to TOSHIBA TC55257CFL. Inverter: sim to MOTOROLA MC74HC04AFR. Silicon Seral Number: sim to DALLAS DS2401Z. Inverter: sim to HITACHI HD74LS04FP. Dual D-type Flip Flops: sim to HITACHI HD74HC74.
J701 J702 and J703 J704 J706 J707 J708 K601		----- JACKS ----- Connector: 18 pins. Connector: 24 pins.  Connector: 4 pins. Connector: 10 pins. Connector: 13 pins. Connector: 5 pins. Relay: sim to TAKAMIZAWA JY9H-K.
R601 R602 R603 R604 R605 R606 R607 R608 R609 R610 and R611 R612 and R613 R614 R615 R616 R617 R618 and R619 R620 R621 R622 thru R624 R625 R626 R627 R628 and R629 R630 R631 R632 R633 R634 R635 R636 R637 thru R639 R640 R641 R642 R643 and R644 R645 and R646 R647 R648 R649 R650		----- RESISTORS ----- Metal film: 15k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 33K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 68k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 120K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 270K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 56K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 150K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 680k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 2.2K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 10k ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 39k ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 4.7K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 100k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 470K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 3.3 M $\pm$ 10%, 200 VDCW 1/10W. Metal film: 100k ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 47K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 22k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 56K ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 10k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 56k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 150k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 100K ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 3.3M ohms $\pm$ 10%, 200 VDCW, 1/10W. Metal film: 47k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 100K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 22k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 1M ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 6.8k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 27k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 10k ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 3.3k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 330k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 10k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 22 ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 1.0k ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 8.2k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 10k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 1M ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 680 ohms $\pm$ 5%, 100 VDCW, 1/16W.

SYMBOL	PART NO.	DESCRIPTION
R652 thru R654 R655 R656 R657 R658 R659 R660 R661 R662 R664 R665 thru R669 R670 R671 R701 thru R703 R704 R705 R706 and R707 R709 and R710 R718 R719 R720 R724 and R725 R726 R729 and R730 R732 R733 R734 R735 R736 R737 thru R740 R741 R742 and R743 R744 and R745 R747 R748 R749 R750 and R751 R753 R754 R755 R756 thru R763 R764		Metal film: 15K ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 56k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 1.0k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 560 ohms $\pm$ 5%, 100 VDCW, 1/4W. Metal film: 15K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 10k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 5.6k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 10k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 100k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 2.2k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 100k ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 100k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 15k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 100 ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 68k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 100 ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 1.0k ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 100 ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 4.7k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 100k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 10k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 2.7K ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 1M ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 0 ohms.  Metal film: 0 ohms. Metal film: 4.7K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 1.0k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 4.7K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 6.8K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 10k ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 27k ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 4.7K ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 470 ohms $\pm$ 5%, 100 VDCW, 1/10W.  Metal film: 0 ohms. Metal film: 10K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 100K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 22k ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 10K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 18K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 27K ohms $\pm$ 5%, 100 VDCW, 1/16W. Metal film: 10K ohms $\pm$ 5%, 100 VDCW, 1/16W.  Metal film: 100K ohms $\pm$ 5%, 100 VDCW, 1/16W.  ----- SWITCHES ----- Slide Switch.
SW601		
TR602 TR603 TR701 TR702 thru TR712 TR713 and TR714 TR715 and TR716 TR717 and TR718		----- TRANSISTORS ----- Transistor NPN: sim to SANYO 2SC3398. Transistor NPN: sim to NEC 2SD596. Transistor NPN: sim to TOSHIBA RN2301. FET: sim to NEC 2SK1582.  Transistor NPN: sim to TOSHIBA 2SC2859.  Transistor NPN: sim to NEC 2SC3736.  FET: sim to NEC 2SK1582.

SYMBOL	PART NO.	DESCRIPTION
X701		----- CRYSTALS ----- Crystal: 9.8304 MHz CP12A.

PARTS LIST  
LOGIC/IF BOARD  
IF SECTION  
CMF-135D  
(Used in P101, P102)

SYMBOL	PART NO.	DESCRIPTION
C500 C501 C502 C503 C504 C505 C506 C507 C508 C509 thru C512 C515 and C516 C521 C522 and C523 C524 C525 C526 C527 C528 C529 and C530 C531 C553 C554 thru C556 C557 C558 and C559 C560 C561 C562 thru C565 C567 and C568 C569 C570 C571 and C572 C573 C574 thru C584	NOTE: Parts listed are for reference only. Refer to Service Section for serviceable parts.	-----CAPACITORS----- Ceramic: 1.5 pF ±0.25 pF, 50 VDCW, temp coef 0±250 PPM. Ceramic: 0.01 µF ±10%, 50 VDCW, temp coef ±15%. Ceramic: 10 pF ±0.5 pF, 50 VDCW, temp coef 0±60 PPM. Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±60 PPM. Ceramic: 10 pF ±0.5 pF, 50 VDCW, temp coef 0±60 PPM. Ceramic: 15 pF ±0.5 pF, 50 VDCW, temp coef 0±60 PPM. Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±60 PPM. Ceramic: 7 pF ±0.25 pF, 50 VDCW, temp coef 0±60 PPM. Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±60 PPM. Ceramic: 0.01 µF ±10%, 50 VDCW, temp coef ±15%.  Ceramic: 0.01 µF ±10%, 50 VDCW, temp coef ±15%.  Ceramic: 0.01 µF ±10%, 50 VDCW, temp coef ±15%. Ceramic: 0.1 µF ±10%, 25 VDCW, temp coef ±15%.  Ceramic: 0.01 µF ±10%, 50 VDCW, temp coef ±15%. Ceramic: 33 pF ±5%, 50 VDCW, temp coef 0±60 PPM. Ceramic: 0.01 µF ±10%, 50 VDCW, temp coef ±15%. Ceramic: 120 pF ±5%, 50 VDCW, temp coef 0±60 PPM. Ceramic: 8 pF ±5%, 50 VDCW, temp coef 0±60 PPM. Ceramic: 0.01 µF ±10%, 50 VDCW, temp coef ±15%.  Ceramic: 1pF ±0.25pF, 50 VDCW, temp coef 0±250 PPM. Ceramic: 0.01 µF ±10%, 50 VDCW, temp coef ±15%. Ceramic: 0.1 µF ±10%, 25 VDCW, temp coef ±15%.  Ceramic: 15 pF ±5%, 50 VDCW, temp coef 0±60 PPM. Ceramic: 0.1 µF ±10%, 25 VDCW, temp coef ±15%.  Ceramic: 1000 pF ±10%, 50 VDCW, temp coef ±15%. Ceramic: 0.01 µF ±10%, 50 VDCW , temp coef ±15%. Ceramic: 0.1 µF ±10%, 25 VDCW, temp coef ±15%.  Electrolytic: 10 µF ±20%, 16 VDCW.  Ceramic: 0.01 µF ±10%, 50 VDCW, temp coef ±15%. Ceramic: 1000 pF ±10%, 50 VDCW, temp coef ±15%. Ceramic: 0.1 µF ±10%, 25 VDCW, temp coef ±15%.  Electrolytic: 10 µF ±20% , 16 VDCW. Ceramic: 0.01µF ±10%, 50 VDCW, temp coef ±15%.  -----FILTERS ----- Crystal Filter: 45.1 MHz.  Ceramic: Filter: 455 KHz. Ceramic: Filter: 455 KHz. Ceramic: Filter: 455 KHz. Ceramic: Filter: 455 KHz.  ----- INTEGRATED CIRCUITS ----- Linear, IF Amplifier/Detector; sim to TOSHIBA TA31132F. Linear, Dual OP AMP; sim to NJRC NJM3404AM. Linear, Positive Voltage Regulator; sim to NJRC NJM78L09UA.

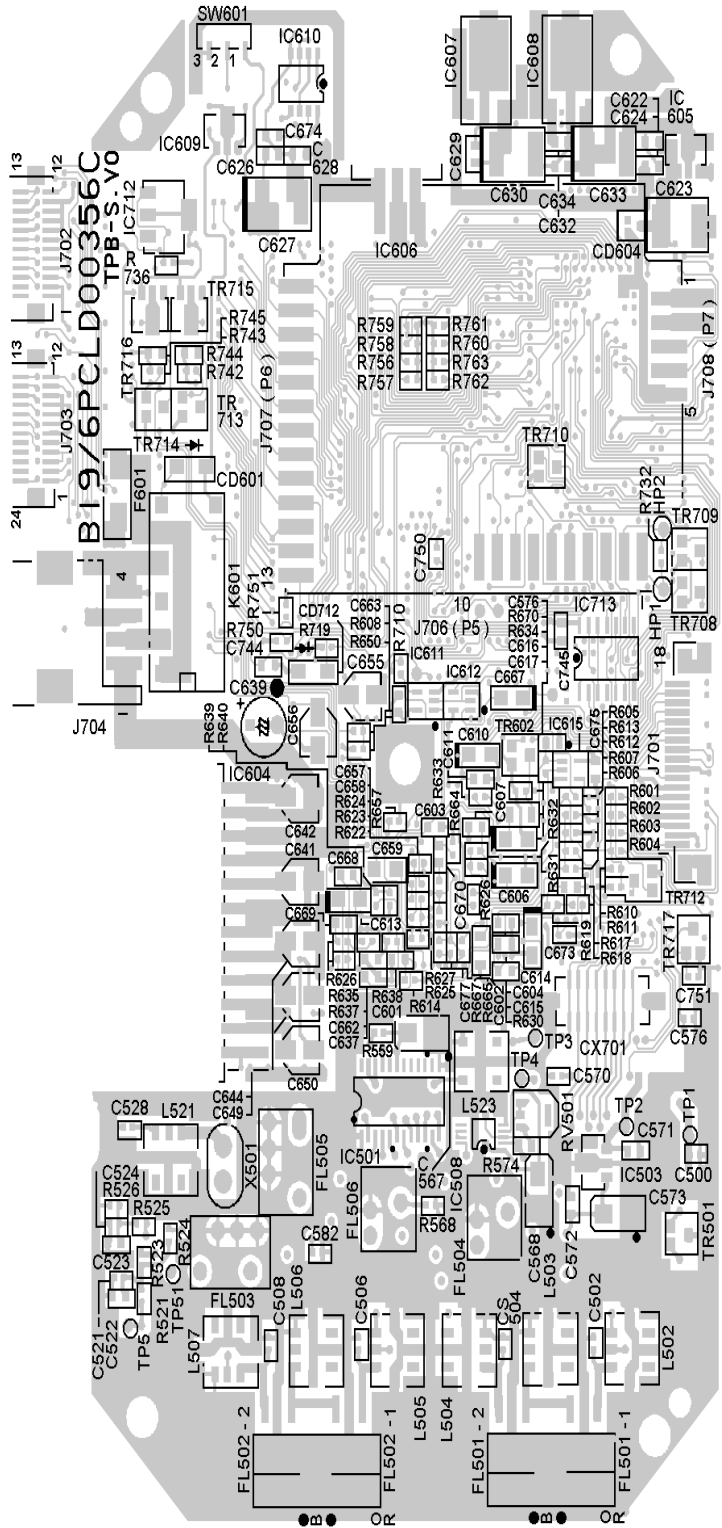
SYMBOL	PART NO.	DESCRIPTION
IC504 thru IC507 IC508 IC509		Linear, Dual Bilateral Switch: sim to TOSHIBA TC4W66F.  Linear, Dual OP Amp: sim to NJRC NJM3404AV. Linear, Bilateral Switch: sim to TOSHIBA TC4S66F.  -----CONNECTORS ----- Connector: 30 Pins.  ----- COILS ----- Coil: RF 1 µH 20%. Coil: RF. Coil: RF. Coil: RF.  Coil: RF. Coil: RF. Coil: RF. Coil: RF 0.22 µH 10%. Coil: RF .  -----RESISTORS ----- Metal film: 82 ohms ±5%, 100 VDCW,1/10W. Metal film: 18 ohms ±5%, 100 VDCW,1/10W. R503 Metal film: 4.7K ohms ±5%, 50 VDCW,1/16W. R505 Metal film: 150K ohms ±5%, 50 VDCW,1/16W. R506 Metal film: 330 ohms ±5%, 50 VDCW,1/16W. R507 Metal film: 8.2K ohms ±5%, 50 VDCW,1/16W. R508 Metal film: 6.8K ohms ±5%, 50 VDCW,1/16W. R509 Metal film: 220 ohms ±5%, 50 VDCW,1/16W. R510 Metal film: 3.3K ohms ±5%, 50 VDCW,1/16W. R511 Metal film: 330 ohms ±5%, 50 VDCW,1/16W. R521 Metal film: 15K ohms ±5%, 50 VDCW,1/16W. R522 Metal film: 4.7K ohms ±5%, 50 VDCW,1/16W. R523 Metal film: 1.5K ohms ±5%, 50 VDCW,1/16W. R524 Metal film: 100 ohms ±5%, 50 VDCW,1/16W. R525 Metal film: 33 ohms ±5%, 50 VDCW,1/16W. R526 Metal film: 1K ohms ±5%, 50 VDCW,1/16W. R527 Metal film: 4.7K ohms ±5%, 50 VDCW,1/16W. R528 Metal film: 10K ohms ±5%, 50 VDCW,1/16W. R529 Metal film: 1K ohms ±5%, 50 VDCW,1/16W. R530 Metal film: 10K ohms ±5%, 50 VDCW,1/16W. R531 Metal film: 100 ohms ±5%, 50 VDCW,1/16W. R552 Metal film: 1.5K ohms ±5%, 50 VDCW,1/16W. R556 Metal film: 1.5K ohms ±5%, 50 VDCW, 1/16W. and R557 R559 Metal film: 820 ohms ±5%, 50 VDCW, 1/16W. R560 Metal film: 18K ohms ±5%, 50 VDCW, 1/16W. R561 Metal film: 56K ohms ±1%, 100 VDCW, 1/16W. thru R564 R565 Metal film: 2.7K ohms ±5%, 50 VDCW, 1/16W. R566 Metal film: 0 ohms, 1/16W. R567 Metal film: 1.8K ohms ±5%, 50 VDCW, 1/16W. and R568 R569 Metal film: 100K ohms ±5%, 50 VDCW, 1/16W. and R570 R571 Metal film: 1.8K ohms ±5%, 50 VDCW, 1/16W. R572 Metal film: 10K ohms ±5% 50 VDCW,1/16W. and R573 R574 Metal film: 1.2K ohms ±5% 50 VDCW,1/16W. R575 Metal film: 10K ohms ±5%, 50 VDCW,1/16W. R721 Metal film: 2.2K ohms ±5%, 50 VDCW,1/16W. RV501 Variable: 10K ohms.  -----TRANSISTORS ----- N-Channel, field effect; 2SK1577.  Silicon, NPN; sim to NEC 2SC2223. Silicon, NPN; sim to HITACHI 2SC2620.  Silicon, NPN; includes resistors; sim to TOSHIBA RN1304.

SYMBOL	PART NO.	DESCRIPTION
X501 XS501A and XS501B		----- CRYSTALS ----- Quartz crystal: 44.645 MHz. Crystal Socket.

PRODUCTION CHANGES

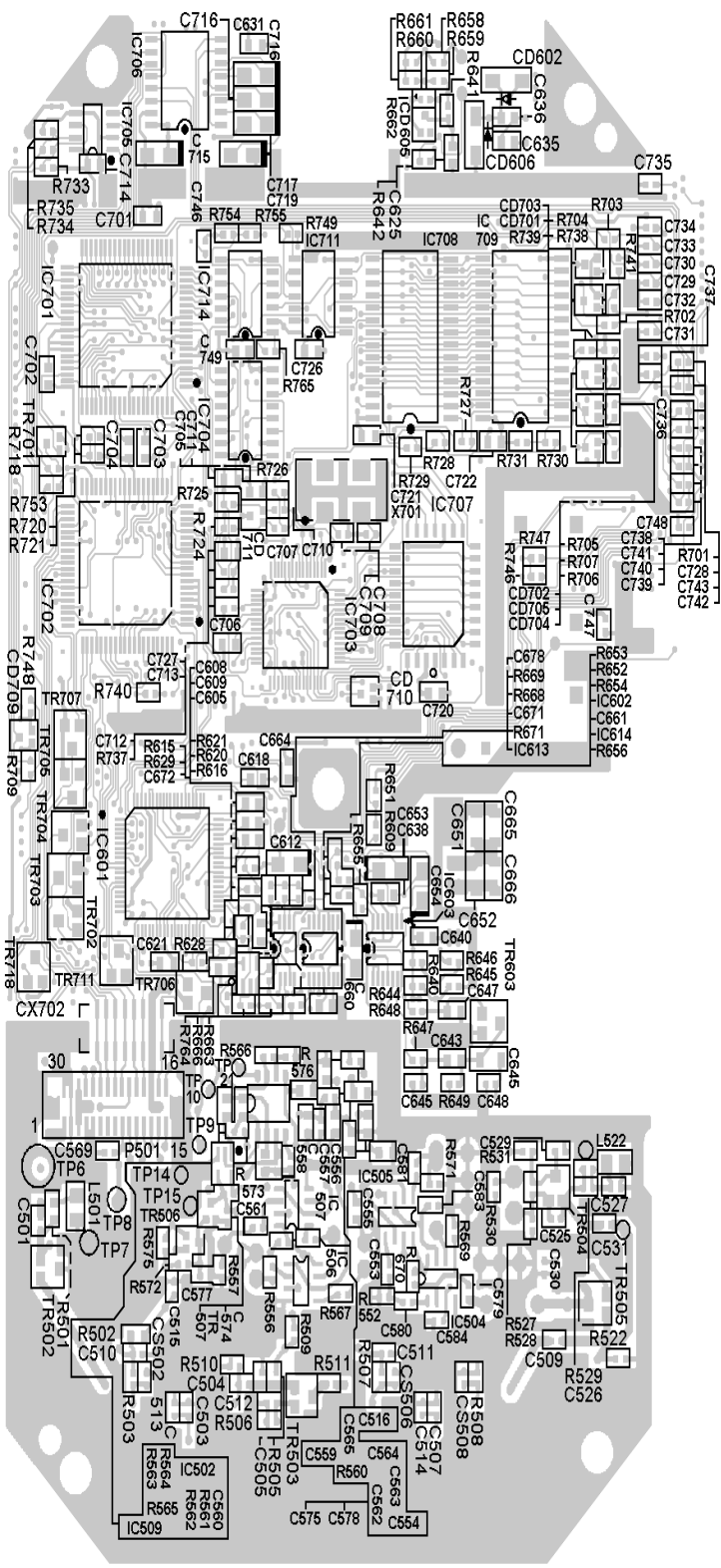
Changes in the equipment to improve or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

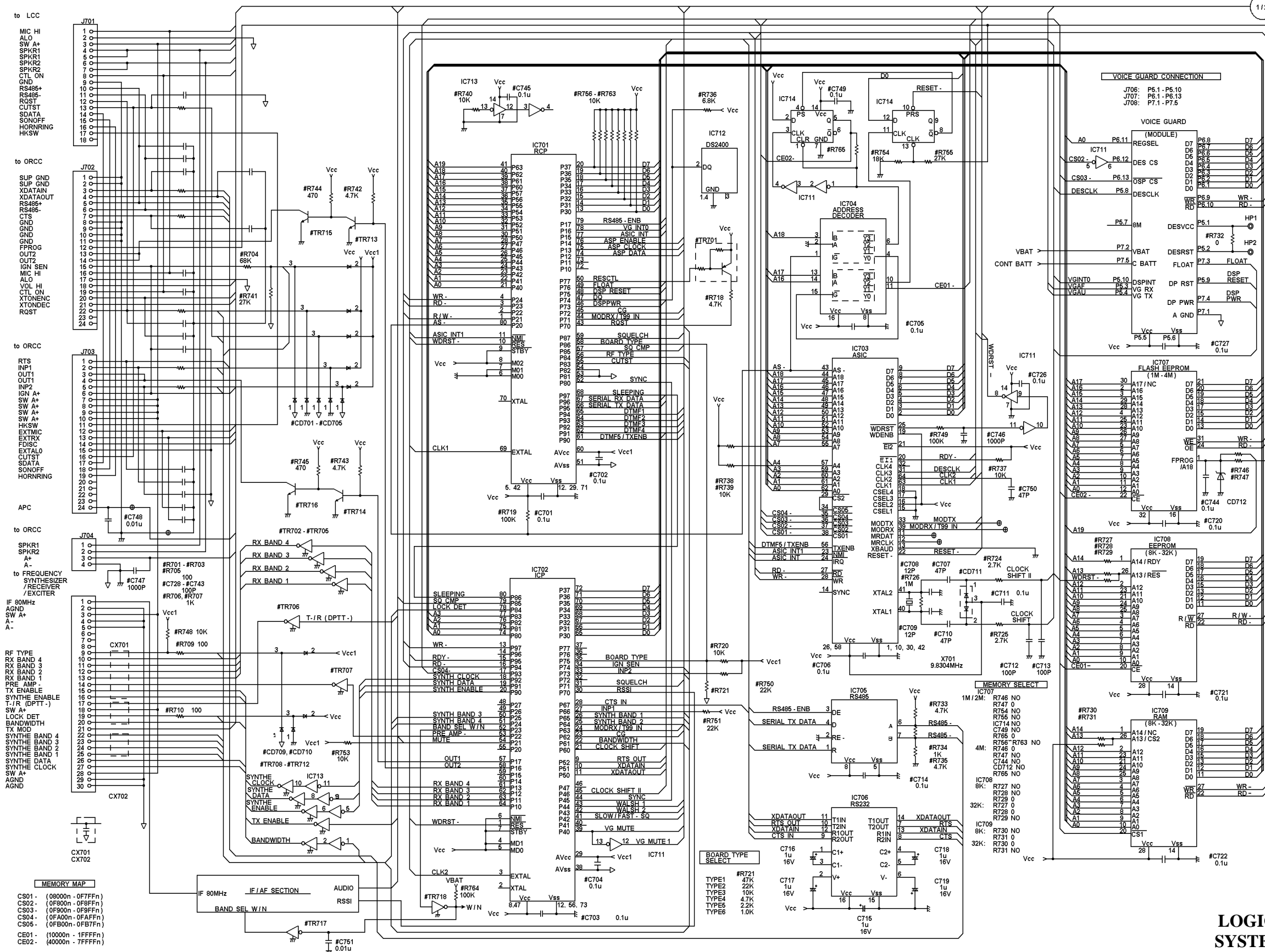
COMPONENT SIDE



6PDL00212C

SOLDER SIDE



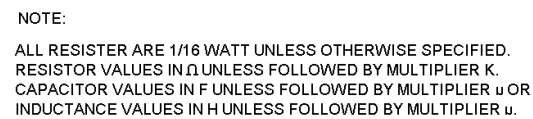


LOGIC (CMC-682D)  
SYSTEM CONTROL

(DD02-CMC-682D 1/2)







**IF(CMF-135D)**  
(DD01-CMF-135D)